COMMISSION D: Electronics and Photonics (November 2010 - October 2013)

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Electronics and Photonics cover huge scientific and technological fields. Among them, in this report, we have selected several important topical areas, where in particular Japanese leading researchers have actively contributed between 2010 and 2013. They overviewed recent remarkable advances in their specialized areas.

The following is a list of areas that the chapter editor has taken up.

D1. Metamaterials E. Sano Hokkaido University

D2. Mid-infrared Quantum Cascade Lasers and Antennas

K. Kasahara Ritsumeikan University

D3. THz Parametric Amplifier

K. Kawase Nagaya University

D4. Broadband Continuous THz Wave Emitters and Detectors

H. Ito Kitasato University

D5. Plasmonic Device Technology for Emission and Detection of Terahertz Radiation

T. Otsuji Tohoku University

D6. Photonic Microstructures for Silicon Photonics Applications

M. Fujita Osaka University

D7. Microwave Multiplexers for Readout of Superconducting Detector Array

S. Kohjiro National Institute of Advanced Industrial Science and Technology

D8. High Capacity Optical Fiber Transmission Systems

H. Toda Doshisha University

D9. Small Cell Configurations using RoF Entrance Network Technologies

K. Tsukamoto Osaka Institute of Technology

D10. Convergence of Wireless and Wired Technologies towards Next Generation Access Networks K. Iwatsuki

Tohoku University

D11. Optical Access Technologies for Mobile Fronthaul

J. Kani NTT

D1. Metamaterials Eiichi Sano Hokkaido University

Recent years have seen the development of wireless sensor networks (WSNs) to realize ubiquitous computing environments. A WSN is a network to get information from wireless sensor nodes located at distant sites. Today, WSNs are used in various fields such as building and apartment security and healthcare monitoring. Small size and low power consumption is needed for wireless sensor nodes to be deployed and to ensure maintenance-free operation in various environments since it is difficult to constantly maintain a huge number of sensor nodes in a manner like that of replacing batteries [1].

The size of a wireless sensor node is mainly determined by antenna size. In recent years, several extensive attempts have been made to fabricate electrically small antennas for system-on-

a-chip (SoC) or system-in-a-package (SiP) application [2], [3]. However, in such antennas the antenna gain is constrained to the Harrington limit, while the impedance matching and directivity characteristics deteriorate. Various methods for reducing antenna size have been reported [3-8]. Using a dipole antenna loaded with a left-handed ladder structure is a promising technique for reducing the size of antennas [5]. When parallel plate capacitors and spiral inductors are fabricated on a printed circuit board (PCB) with a thickness of a few mm, however, the sizes of the capacitors and the widths of the spiral inductors are expected to be more than 4×4 mm and 2 mm for achieving left-handed components operating at 2.4 GHz, and these components cannot reduce the antenna size to less than a conventional dipole antenna. In contrast, lumped components of inductors and capacitors with sizes of 0.4×0.2 and 0.6×0.3 mm are commercially available.

In this report, the left-handed dipole antenna with the right/left-handed ladder structure was designed and fabricated using lumped inductors and capacitors.

The length for a standard half-wavelength dipole antenna operating at 2.4 GHz is about 6 cm, which is too long to achieve a small-size sensor node. On the other hand, we encounter a problem that the antenna gain degrades as the antenna size is reduced. The highest achievable gain of an electrically small antenna that can be enclosed within a sphere of effective radius r is given by

$$G = (kr)^2 + 2kr \tag{1}$$

where *k* is the wave number. The highest gain for small antennas operating at 2.45 GHz is calculated to be 1.0 dBi with an antenna length of 20 mm corresponding to $0.16\lambda_0$ and kr = 0.502 (λ_0 : free space wavelength).

The circuit configuration of the designed antenna is depicted in Fig. 1(a). The antenna was composed of series inductors L_R and shunt capacitors C_R used as right-handed elements and shunt inductors L_L and series capacitors C_L used as left-handed elements. The distributed elements of the two parallel transmission lines were used as the right-handed components. The unit cell combined T-type left-handed elements of a shunt inductor and two series capacitors with righthanded transmission lines. The number of unit cells N was 4. The antenna geometry and the values of C_L and L_L were chosen on the basis of composite right/left-handed transmission line theory [9]. The dispersion characteristics for a composite right/left-handed transmission line is given by

$$\beta p = \cos^{-1} \left[1 - \frac{1}{2} \left\{ \left(\omega L_R - \frac{1}{\omega C_L} \right) \cdot \left(\omega C_R - \frac{1}{\omega L_L} \right) \right\} \right].$$
⁽²⁾

The values of L_R and C_R in the parallel transmission lines are given by

$$L_{R} = \frac{p\mu_{0}}{\pi} \ln\left(\frac{H}{R}\right), \quad C_{R} = \frac{\pi p\varepsilon_{0}\varepsilon_{r}}{\ln(H/R)}$$
(3)

where *H* is the distance between the two parallel lines and *R* is the half line width [6]. Since both ends of the lines are open, the phase difference between the two open ends must be π at the operating frequency. This means that βp must equal $\pi/4$ at the target frequency of 2.4 GHz. The designed values were: the unit cell size = 5 mm, *H* = 2 mm, *R* = 0.15 mm, *C*_L = 0.5 pF, and *L*_L = 3.9 nH. The antenna was simulated with a finite-difference time-domain (FDTD) electromagnetic simulator (EMpro, Agilent).

A T-junction balun was designed for the differential signal input to the dipole antenna. The balun was composed of a high-pass filter (HPF), a low-pass filter (LPF), and a T-junction [Fig. 1(b)]. Fifth-order LC circuits were used for the HPF and LPF, which shifted the signal by $+90^{\circ}$ in the leading phase and -90° in the lagging phase, respectively. Each element of the balun was simulated with a circuit simulator (ADS). Finally, the impedance matching was simulated for the left-handed antenna combined with the T-junction balun.

The antenna with balun was constructed on FR4 substrate with a thickness of 1.6 mm. Commercially available chip capacitors and inductors with a size of 0.6×0.3 mm were used. Fig. 1*b* shows a photograph of the fabricated antenna with balun. To eliminate the effect of variation in the lumped elements, we fabricated four antennas and averaged the measured characteristics.

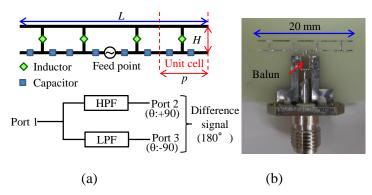


Fig. 1. Configuration of left-handed dipole antenna with balun and photograph of fabricated antenna with balun. (a) Circuit configuration. (b) Photograph.

The fabricated antennas were measured using a standard dipole antenna with a gain of 2.14 dB and a vector network analyser (VNA). Port 1 of the VNA was connected to one of the fabricated antennas, and Port 2 of the VNA was connected to the dipole antenna. The gain was calibrated with the gain measured between two standard dipole antennas.

Fig. 2(a) shows the measured return losses for each antenna. An impedance matching of less than -10 dB was obtained in the frequency band from 2.4 to 2.5 GHz. The matching between designed and measured return losses was quite good. Fig. 2(b) shows the actual gain for the

antenna. The measured antenna gain was -0.01 dBi. The simulated antenna gain (-0.66 dBi) was slightly lower than the measured gain. The difference might have been caused by the variation in the lumped elements and the effect of the solder used to mount the components. Fig. 3 compares measured and simulated directivities. The directivity of the fabricated antenna was measured by changing the angle/theta from 0 to 90 degrees by 5 degree steps in the E-plane. A fairly good agreement was obtained for all degree steps. Fig. 4 compares the antenna gains achieved in this work with those reported in previous literature [3]-[5], [7], [8]. Their measurement values are the highest gain ever achieved for the antennas at the same kr operating at 2.45 GHz.

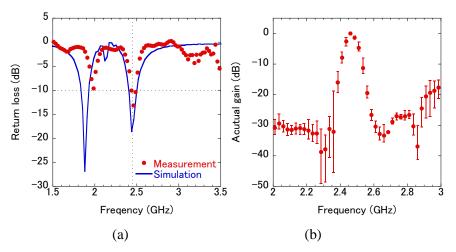


Fig. 2. Return loss and actual gain. (a) Measured and simulated return losses. (b) Measured actual gain.

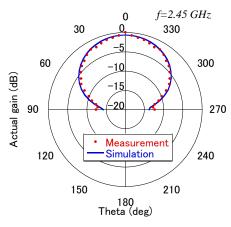


Fig. 3. Comparisons between measured and simulated directivity in E-plane.

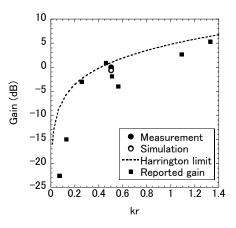


Fig. 4. Comparison of fabricated antenna gain with those reported in literature [3]-[5], [7], [8].

On the basis of the composite right/left-handed transmission line theory, we designed the lefthanded antenna with the lumped components to reduce the antenna size. The actual gain of the fabricated antenna was -0.01 dBi, which was about 1 dB lower than the Harrington limit and the highest ever achieved for fabricated antennas operating at around 2.45 GHz (kr = 0.502).

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D2. Mid-infrared Quantum Cascade Lasers and Antennas

K. Kasahara Ritsumeikan University

Significant progress in mid-infrared distributed-feedback (DFB)-quantum cascade lasers (QCLs) capable of continuous-wave (cw) operation above room temperature has allowed for the monitoring of trace gases relating to environmental and energy issues [1], [2]. Theoretical treatment for the relative intensity noise (RIN) of QCLs and the laser power modulation due to the light returning from the detector at liquidnitrogen temperature, have been reported so far. However, there have been no experimental reports discussing the RIN of DFB-QCLs, following the gained knowledge of the linewidth enhancement factor, α , and optical coupling efficiency. Therefore, a new method using a movable reflection mirror was reported to obtain both parameters experimentally (Fig. 1), where a commercially available 6.1 μ m DFB-QCL with a cw threshold current of $I_{\rm th}$ = 461 mA at 253 K was used [3]. An Alcoated reflection mirror mounted on a voice coil was placed at the end of one arm. The other beam transmitted through the beam splitter was collected by another ARcoated CaF₂ lens, and focused onto a Peltier-cooled HgCdTe photovoltaic detector (MCT-PV). After the RIN measurements were taken, the mirror was moved back and forth by the voice coil to observe the self-mixing waveform, which was taken out through a capacitor, to extract the feedback parameter, C, which is defined as follows:

$$C = \frac{2\varepsilon L_e \sqrt{1 + \alpha^2 r_e |C_1|}}{nl},\tag{1}$$

where ε represents the coupling efficiency of returning light to a laser, L_e is the distance between a laser chip and an external mirror, r_e is amplitude reflectivity of the reflection mirror, l is the cavity length (QCL: 2 mm), and n represents the refractive index. C_1 is a complex coefficient which depends only on solitary DFB laser modal characteristics. Figure 2 shows the RIN as a function of a normalized pumping current $a (= III_{\rm th}-1)$. There wasn't any marked change in the RIN. The α -parameter and C of the QCL obtained from the self-mixing waveform were concluded to be about -2.2 and 2.9. To estimate ε , one needs to know C_1 shown in (1). C_1 was 4.0 × 10⁻¹ < C_1 < 7.7 × 10⁻¹, and the respective coupling efficiencies calculated from (1) was 2.0 × 10⁻² < ε < 3.8 × 10⁻². Therefore, the coupling efficiency was estimated to be more than 2.0% at least. The estimated coupling efficiency of the light returning to the QCL was at such a level that it would result in the coherent collapse if it were DFB-lase diodes (LDs). However, the RIN was almost the same as that without feedback.

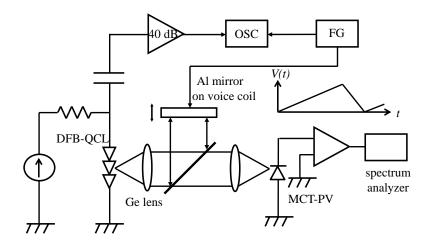


Fig. 1. Experimental setup used for the RIN measurements of the DFB-QCL. Asymmetric triangular voltage with an up and down ratio of 80:20 % was applied to the voice coil at a 150 Hz repetition rate [3].

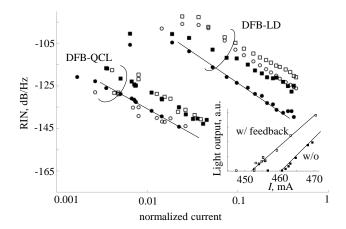


Fig. 2. RIN vs. normalized current for the DFB-QCL and DFB-LD. Square: 2.5 MHz and circle: 40 MHz. Closed and open symbols correspond to the case without and with feedback, respectively. Inset shows the light output vs. current characteristics of the QCL. L_e was set to be ~ 1 m for the QCL, and was ~ 5cm for the LD [3].

The application of QCLs needs more sensitive detectors in the mid-infrared range. Optical antennas can enhance optical harvesting efficiency, which can be utilized for this purpose [4], [5]. The field intensity becomes large near the antenna, which, however, falls drastically at positions distant from it. Very little experimental work showing the field enhancement distribution of the antenna in a vertical direction was available in published literature. To know that, a thin dielectric layer was deposited on a Si substrate with the use of atomic layer deposition (ALD), and dumbbell-shaped slot antennas were fabricated on it [6]. It was possible to grow the layer with the thickness being controlled to an accuracy of ~1 nm. By observing the spectra reflected off antenna arrays with different layer thicknesses, an understanding of the vertical field distribution could be gained (i.e. the field localization and the magnitude of the field enhancement). The reflection spectrum of one antenna array was measured using a microscopic FT-IR with an aperture size of 24 μ m x 24 μ m. The reflection spectrum was normalized by the reflectivity from the Au film on the substrate. Figure 3 shows the results for antenna arrays on an Al₂O₃/Si substrate. The thicknesses of Al_2O_3 were 0, 2, 4, and 6 nm. The dip appearing around 1250 cm⁻¹ weakened as the Al_2O_3 was thick, and for 6 nm, it disappeared. The characteristic spectral change appearing in the arrays were caused by a thin SiO_2 layer naturally formed on the Si substrate, and it was attributed to the surface phonon polariton. The combination of the antenna and a quantum cascade laser would yield attractive mid-infrared microscopic analysis to detect a solid state surface.

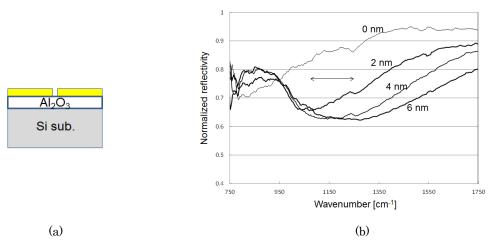


Fig. 3. Antenna arrays on an Al₂O₃/Si substrate. (a) Cross-section view. $L= 2.5 \mu m$, $W = 0.6 \mu m$, $A = 0.2 \mu m$, and $G = 0.1 \mu m$. (b) Reflection spectra for Al₂O₃ having thicknesses of 0, 2, 4, and 6 nm [6].

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D3. THz Parametric Amplifier

K. Kawase Nagaya University

Terahertz wave parametric generation and amplification is based on both second and third order non-linear processes. Among the polar non-linear crystals, such as LiTaO₃ and GaP, we selected LiNbO₃ for a number of reasons. Firstly it has a large nonlinear coefficient. It also has a high figure of merit and high transparency over a wide infrared wavelength range. Moreover, the laser induced damage threshold of this crystal is high, making it possible to use higher peak power pump sources without damage to the crystal.

When an intense laser beam propagates through a non-linear crystal, the photon and phonon transverse fields are coupled and behave as new mixed photon-phonon states, called polaritons. The efficient parametric scattering of light via a polariton (called stimulated polariton scattering) results in the generation of an idler beam, whereby THz-wave can be generated. The output of such a system produces a wide range of THz frequencies. However, when a single frequency seed beam is injected at a specific fixed angle of incidence to the crystal, such that phase matching conditions are met, coherent THz-wave is generated [1]. This process, known as injection seeding, offers a wide frequency range of THz-wave which is tuned simply by varying the wavelength of the seed beam. Using exactly the same principal, we use the THz wave thus generated (which we call the weak THz field) as a seed beam. By seeding the THz wave with a specific wavelength, the corresponding idler beam can be amplified, and this in turn leads to amplification of the THz-wave. In this process the non-collinear phase matching condition is accomplished by adjusting the angle of incidence of the THz seed beam to the LiNbO₃ crystal.

The experimental setup is shown in Fig. 1. The system consisted of two distinct parts. Firstly a THz wave emission section which comprised a pump laser, laser amplifier, seed beam laser and nonlinear crystal. The second part was the THz amplifier section, comprised of a pair of nonlinear crystals and a pyroelectric detector to measure the emitted THz power. As a pump source we used a single-mode microchip Nd:YAG laser [2]. The pumping beam was amplified by two optical amplifiers and extracted using a polarizing beam splitter (PBS). This setup amplified the laser power to 14 mJ/pulse. A continuous wave, tunable external cavity diode laser (ECDL, Velocity 6300, New Focus Inc.) was used as an injection seeder for the idler beam. Both pump beam and seed beam irradiated the 5-mol % MgO:LiNbO₃ crystal at a specific angle as shown in the inset of Fig. 1. We used a 50 mm long crystal with an antireflection coating for a wavelength of 1064 nm. The polarization orientation of the pump, seed, idler and THz waves were all parallel to the

z-axis of the crystal. The emitted THz-wave had pulse energy of 100 nJ typically, a temporal width of 100 ps and a line width of 5 GHz [3].

For amplification of this THz-wave, we used two nonlinear MgO: LiNbO₃ crystals in series. These crystals were also pumped by the microchip Nd:YAG laser beam. The THz wave was collimated using a cylindrical lens and efficiently coupled to the nonlinear crystal using a Silicon prism. The THz wave was incident on the crystal so as to roughly satisfy the nonlinear phase matching condition. The angle between the pump and idler beam was therefore small whereas the angle between the pump beam and the THz wave was large. This geometry of beams made it relatively easy to arrange for the weak field THz-wave to be brought to the second nonlinear crystal as a seed beam. In order to minimize absorption loss of the THz wave and to ensure efficient coupling between the pump beam and the THz wave inside the lithium niobate crystal, we arranged for the pump laser to be as close as possible to the Silicon prism. Moreover, the pump laser and THz wave were temporally overlapped by adjusting the optical path length. In this arrangement, the weak THz field acted as a seed beam and due to the interaction between the laser and THz seed beam in the crystal, amplified THz-wave was emitted. The amplified THz wave within the nonlinear crystal will suffer total internal reflection due to the high refractive index of the MgO: LiNbO₃ unless we use an appropriate output coupling medium. We used a Si-prism coupler (n=3.4) on the y surface of the crystal to extract the THz wave from the crystal. This pulsed THz-wave was finally detected by a pyroelectric detector (SPI-A-65 THz, Spectrum Detector Inc.). We have successfully demonstrated a direct amplification of coherent THz-wave with gain of more than 50dB. Pronounced gain was observed when the input THz pulse energy was between 20 aJ and 20fJ. The maximum gain observed was 4*10⁵ where 1.8 fJ THz pulse input was amplified up to 740 pJ. However in the higher input pulse energy regime (>20 fJ), the gain decreased due to the saturation of parametric gain in the nonlinear crystal.

Significant amplification of THz-wave as demonstrated here represents an advance in the general applicability of THz techniques. This amplification method of THz-wave can be implemented to compensate for losses in strongly absorbing samples in spectroscopic and imaging systems. Furthermore, amplification of THz-wave above the detection threshold of room temperature detectors greatly improves the applicability of, and enhances the versatility of THz sources. At the same time costs and sophistication are reduced by eliminating the need for high power THz sources.

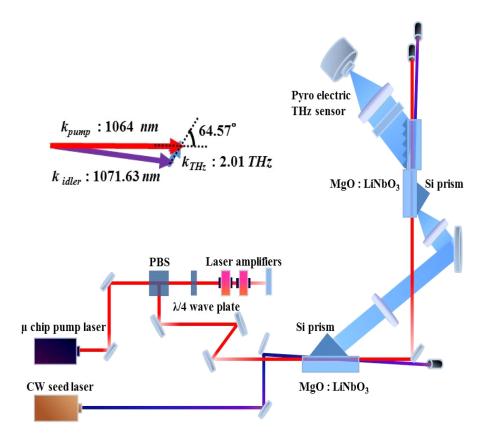


Fig. 1. Experimental setup for the emission and amplification of THz-wave. The pump laser ($\lambda = 1064$ nm, energy = 700 µJ/pulse, pulse width = 420 ps, repetition rate = 100 Hz, M² = 1.09) is amplified by two optical amplifiers in a double pass configuration. The inset shows a typical phase matching condition for generation and amplification of THz-wave with a frequency of 2.01 THz. In this figure, polarizing beam splitter and continuous wave are abbreviated as PBS and CW respectively.

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D4. Broadband Continuous THz Wave Emitters and Detectors

H. Ito

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Terahertz (THz) wave emitters and detectors are indispensable components in various systems. As the emitter, we consider the photomixer is promising for generating continuous-waves because of its superior features, such as wide frequency tunability, narrow line width, and the capability for long distance transmission of high frequency signals through low loss fibers [1, 2]. The use of long wavelength (around 1.55 µm) light signals is also advantageous for practical applications since we can use numerous optical components developed for optical communications systems at reasonable cost. The basic requirements for the photomixer are to have both high operation speed and high output current. In this regard, the uni-traveling-carrier photodiodes (UTC-PDs) is one of the best solutions because they provide a high 3-dB down bandwidth and a high saturation output current, simultaneously [1, 2]. As the detector, the Schottky barrier diode (SBD) is one of the most practical devices [3-5]. It can be operated at up to THz-wave range, and provides reasonably high sensitivity at room temperature. The capability for zero-biased (unbiased) operation is also promising for making the system simpler, more flexible, and less expensive. For this purpose, InP and its related (lattice-matched) compounds is superior since they have smaller Schottky barrier heights so that the optimum operation condition exists near the zero bias voltage [5]. These semiconductor-based devices are practically important because they have good reliability, reasonable cost, and are suitable for integration with other semiconductor devices and passive components.

For the actual applications, these devices have to be assembled in a package that has a way to efficiently transmit/receive high-frequency signals. There are two possible approaches for this purpose. One is to use a waveguide-output module [3-5], and the other is to use a quasi-optical configuration [6, 7]. The waveguide-output approach is effective for coupling the signal with the output/input port of the objective. In addition, we can easily control the radiation pattern (coupling efficiency) of the signal by using an appropriate external antenna, such as a horn antenna. The drawback of this approach is that the bandwidth of the fundamental mode signal is essentially restricted by the waveguide nature. In contrast, the key advantage of the quasi-optical configuration is that it can be extremely wideband so that the full bandwidth can be covered with only one device. Drawbacks of this approach are that it requires a quasi-optical collimation (focusing) system and the integration of an appropriate antenna with the device. To push forward the latter approach, we have developed quasi-optical UTC-PD and SBD modules. Figure 1 shows the fabricated UTC-PD module [6]. The fabricated SBD module has the same

dimension with this package except for the optical fiber connection port. Each device was assembled on a Si hyper-hemispherical lens, and electrically/optically connected with bias-leads/optical fiber. In this configuration, the design of the integrated planar antenna with the device is essential for realizing very broadband characteristics.

For the InP/InGaAs UTC-PD module, we designed an antenna that merged a selfcomplementary 90° bowtie antenna with a longer broad-area dipole antenna to extend its operation frequency toward lower frequencies without significantly increasing the size of the device. Figure 2 shows the frequency characteristics of the detected output power from the fabricated UTC-PD module at a photocurrent of 6 mA [6]. The output power peaked at around 170 GHz and gradually decreased with increasing frequency. We could detect output powers at frequencies from 30 GHz to 1.6 THz (over more than five octaves) from a single device. The effective resonant frequencies for the 90° bowtie region and the entire dipole region were calculated to be about 195 GHz for the former and 50 GHz for the latter. These values agree fairly well with the experimentally obtained resonant frequencies of about 170 GHz and 55 GHz. Thus, the fabricated device was considered to have a hybrid operating mode that was related to both the bowtie antenna and dipole antenna structures, and this was the key to achieving the extremely-wide bandwidth for the fabricated merged antenna.

For the InP-based SBD module, we also designed a similar hybrid antenna. Figure 3 shows the frequency characteristics of the voltage sensitivity for the fabricated module at a zero-bias condition [7]. The SBD sensitivity increased gradually at first and then decreased rather rapidly with increasing frequency. We could detect signals at frequencies from 30 GHz to 1 THz (over more than five octaves) using a single device. In the lower frequency range below about 300 GHz, we observed resonant characteristics where the sensitivity exhibited peaks and valleys at specific frequencies. This behavior is attributed to the detection characteristics of the dipolelike antenna. In contrast, at the higher frequency range above 300 GHz, the sensitivity decreased with increasing frequency without apparent resonant characteristics. The gradient of the sensitivity against the frequency was close to the minus fourth power of frequency, indicating that the intrinsic and extrinsic SBD parameters determined the frequency characteristics, and that the integrated antenna was very broadband. Thus, we considered the signals in this region to be detected by the bowtie antenna. From these results, the fabricated device was again regarded to have a hybrid operating mode, and this was the key to achieving the extremely-wide bandwidth operation.

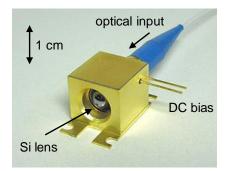


Fig. 1. Photograph of fabricated quasi-optical UTC-PD module (ref. 6).

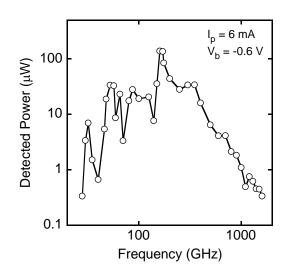


Fig. 2. Frequency dependence of detected power against operation frequency for fabricated UTC-PD module (ref. 6).

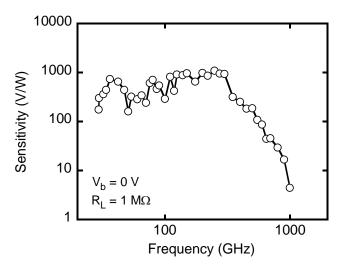


Fig. 3. Frequency dependence of sensitivity for fabricated SBD module (ref. 7).

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D6. Plasmonic Device Technology for Emission and Detection of Terahertz Radiation T. Otsuji Tohoku University

1. INTRODUCTION

In the research of modern terahertz (THz) electronics, development of compact, tunable and coherent sources and detectors operating in the THz regime is one of the hottest issues [1]. Twodimensional (2D) plasmons in semiconductor nano-heterostructures like electron channels in high-electron mobility transistors (HEMT's) have attracted much attention due to their nature of promoting emission and detection of THz electromagnetic radiation [2, 3]. On the other hand, graphene, a monolayer carbon-atomic honeycomb lattice crystal, has attracted attention due to its peculiar carrier transport properties owing to the massless and gapless energy spectrum [4]. Optical and/or injection pumping of graphene can exhibit negative-dynamic conductivity in the THz spectral range [5, 6], which may bring new types of THz lasers. This paper reviews recent advances in emission and detection of terahertz radiation from 2D electron systems in III-V semiconductor and graphene nano-heterostructures.

2. THZ EMISSION AND DETECTION USING 2D PLASMONS

2.1 THz Emission from 2D Plasmons in HEMTs

We have proposed our original 2D-plasmon-resonant micro-chip emitter as a new terahertz light source [7-10]. The structure is based on a HEMT and featured with interdigitated dualgrating gates (Fig. 1). The dual grating gates can alternately modulate the 2D electron densities to periodically distribute the plasmonic cavities (~100-nm width in microns distance) along the

channel, acting as an antenna [7]. Under pertinent drain-source dc bias conditions, dc electron drift flows may promote the instability owing to (i) periodic modulation of electron drift velocities [11], which is called hereafter as Ryzii-Satou-Shur (R-S-S) instability, and (ii) Doppler-shift effect at the asymmetric open-short boundaries [2], which is called

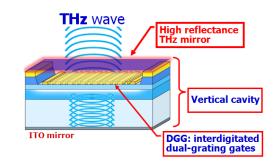


Fig. 1. Schematic and SEM images of a DGG-HEMT with a vertical cavity.

hereafter as Dyakonov-Shur (D-S) instability, resulting in self- oscillation with characteristic frequencies in the terahertz regime. The device was fabricated using InGaP/InGaAs/GaAs and/or InAl/InGaAs/InP material systems [8-10]. So far a broadband THz emission ranging from 1 to ~6 THz has been obtained reflecting multimode of coherent/incoherent plasmons [2], for which oblique modes [12], hot plasmons, and chirped plasmon modes [8] are of the major The DGG-HEMT THz causes. work emitter for terahertz can spectroscopic and imaging applications as an incoherent broadband terahertz microchip source, demonstrating fine identification of water vapor absorptions as well as finger prints of sugar groups [9].

In order to realize coherent monochromatic THz emission we introduced our original asymmetric DGG (A-DGG) structure (Fig. 2(a)) [13] and an improved resonantenhanced high-Q vertical cavity structure (Fig. 2(b)) [7]. In the A-DGG structure the DGG is implemented with asymmetric interfinger spaces, which originates a strong asymmetric field distribution for a unit section of the DGG periodic structure, resulting in significant promotion of the D-S instability [2, 13]. We expect so called 'giant'

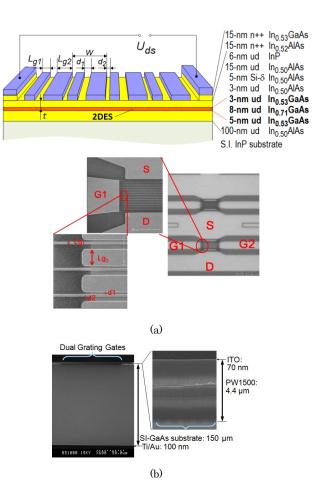


Fig. 2. Schematic view and SEM images (a) and crosssectional TEM images (b) of an A-DGG HEMT. Lg1 = 200nm, Lg2 = 1600 nm, d1 = 200 nm, d2 = 400 nm.

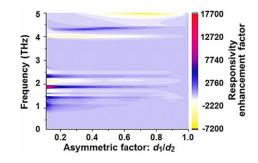


Fig. 3. Simulated responsivity enhancement factor for an A-DGG HEMT under drain-unbiased conditions as a function of the asymmetry factor d_1/d_2 with respect to that for a symmetric DGG HEMT for a dc drain bias current density of 0.1 A/m. $L_{g1} = 200$ nm, $L_{g2} = 1.6 \mu$ m, $d_1 + d_2 = 600$ nm, $W = 2.4 \mu$ m. Electron density under the gate G2 is 2.5×10^{11} cm⁻² whereas that is 2.5×10^{12} cm⁻² under the gate G1.

plasmon instability as a result of cooperative effects between the R-S-S and D-S instability mechanisms, accelerating the injection locking operation. As a result it is expected that the hot-plasmons' originated incoherent spontaneous emission gives rise to stimulated super-radiant emission. Terahertz electric field distribution and resultant photoresponse were numerically simulated using a self-consistent electromagnetic combined approach with the perturbation theory for the hydrodynamic equations for 2D plasmons in HEMTs under periodic electron density modulation conditions [13]. Figure 3 shows giant enhancement of the responsivity (by four orders of magnitude) in an asymmetric DGG HEMT under drainunbiased conditions with respect to that for a symmetric DGG HEMT for a dc drain bias current density of 0.1 A/m. When the asymmetric DGG HEMT is dc-drain biased. the asymmetry of the plasmonic cavity is enhanced enormously, resulting in further enhancement of the responsivity by an order of magnitude. It is reasonable to suggest that similar enhancement should be also exhibited for the plasmon instability in the asymmetric DGG HEMT.

AC-DGG HEMTs were designed and fabricated using

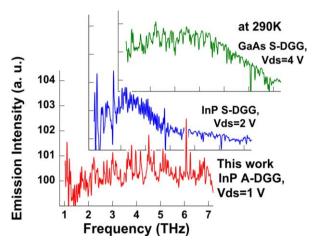


Fig. 4. Measured emission spectra at 290K for different material systems and DGG structures.

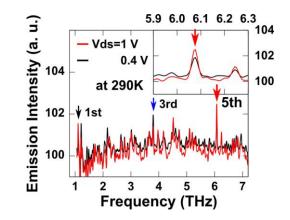


Fig. 5. Measured emission spectra of the InP-based A-DGG HEMT at 290K for different V_{ds} conditions. V_{g1} and V_{g2} are fixed at 0 V and -0.55 V, respectively.

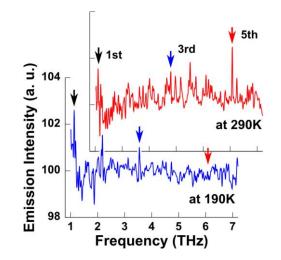


Fig. 6. Temperature dependence of the emission spectra of the InP-based A-DGG HEMT under optimal biased conditions ($V_{ds} = 1 \text{ V}$, $V_{g1} = 0 \text{ V}$, $V_{g2} = -0.55 \text{ V}$).

InAlAs/InGaAs/InP materials (see Fig. 2(a)). Two grating gates G1 and G2 were formed with 70nm thick Ti/Au/Ti by a standard lift-off process. Asymmetric factor, the ratio of the inter-finger spaces, d_1/d_2 , was fixed to be 0.5. The grating gates G1 with narrower fingers L_{g1} , serving plasmon cavity gates, were designed to be chirped ranging from 215 to 430 nm. After processing the AC-DGG HEMT, a high-Q vertical cavity with a high finess of ~60 was formed with a 4.4-µm thick transparent PW1500 resist as a low-loss buffer layer and a 70-nm thick ITO mirror coat on top and a 100-nm Ti/Au coat on polished back surface (see Fig. 2(b)). Its fundamental resonant frequency (free spectral range of the Fabry-Perot modes) was designed to be 65 GHz.

The fabricated HEMTs exhibit normal dc transfer characteristics with good pinch-off and gate modulations for both G1 and G2 with threshold levels of -1.1 and -0.9 V, respectively. We conducted THz spectroscopic measurements for the fabricated devices using a Fourier-transform far-infrared spectrometer and a 4.2-K-cooled Si composite bolometer. The gate bias for the plasmon cavities V_{g1} was fixed at 0 V. Material- and structure-dependent emission spectra at 290K are plotted in Fig. 4 in comparison with previously reported GaAs-based and InP-based symmetric DGG HEMTs. The drain bias was set so as to equal the voltage drop along a unit DGG section among all the devices. Superiorities of the A-DGG structure and InP based materials with higher electron mobility (~11,000 cm²/(Vs)) reflects intense back-ground-less emission of Fabry-Perotmodes. The highest peak intensity is observed at ~6.2 THz with a sharp linewidth ~1.23 cm⁻¹ (~37GHz) corresponding to the 5th plasmon mode. Figure 5 plots the dependence of the emission spectra on V_{ds} under an optimal V_{g2} condition ($V_{g2} = -0.55$ V). When V_{ds} decreases from 1.0 to 0.4 V, both D-S and R-S-S instabilities are weakened so that the stimulated coherent emission is suppressed. This may increase the hot-plasmon-originated spontaneous broadband emission and thus the monochromaticity on emission spectra is degraded. When the temperature cools down to 190K, hot-plasmons- originated residual spurious modes are suppressed, resulting in intense monochromatic emission at the 1st (at 1.2 THz) and 3rd (at 3.6 THz) plasmon modes whose frequencies match to adjacent Fabry-Perot modes, respectively, as shown in Fig. 6. The emission peak at the 5th (at 6.1 THz) plasmon mode is disappeared, which is considered to be caused by the temperature dependence of the 2D electron density in the plasmon cavities reflecting frequency detuning of the plasmon modes.

2.1 THz Detection Using 2D Plasmons in HEMTs

The possibility of the THz detection in a HEMT structure is due to the nonlinearity of the 2D plasmon dynamics, which lead to the rectification of the THz radiation. As a result, a photoresponse appears as a dc voltage between source and drain in proportion to the radiation intensity (photovoltaic effect) [3]. Depending on the quality factor of the 2D plasmon cavity, which is characterized by the product of incoming THz angular frequency ω and electron momentum relaxation time τ , the detection operation is categorized in the "resonant" mode $(\omega \tau > 1)$ or "non-resonant" mode $(\omega \tau < 1)$ [3, 14]. We have demonstrated so far several THz imaging

experiments using standard singlegate (SG) HEMTs [14, 15] as well as DGG-HEMTs [16], confirming the potentiality of the plasmonic HEMTs as a powerful THz detector.

In order to improve the detector responsivity, pertinent antenna structure should be introduced. А smart design of a narrow band antenna has been proposed in [17] where the SG electrode is designed as a dipole antenna, demonstrating an excellent responsivity 1 kV/W at 1 300K. THz at The obtained responsivity exceeds that for Schottky barrier diodes. In terms of broadband antennae, log-periodic or log-spiral as well as grating-gate (GG) are frequently utilized. The DGG structure [7] is an improved type derived from the GG type but still suffers from low responsivity. Our original A-DGG structure can surpass this critical limit [13] because the unit cell of the A-DGG structure can create strong build-in asymmetric field. The THz photoresponse

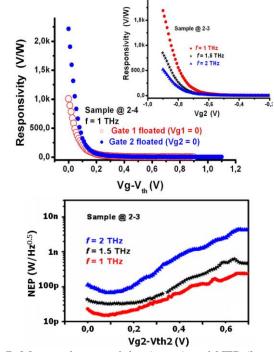


Fig. 7. Measured responsivity (upper) and NEP (lower) of fabricated A-DGG HEMTs at 300K [18].

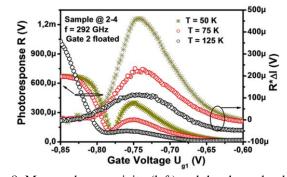
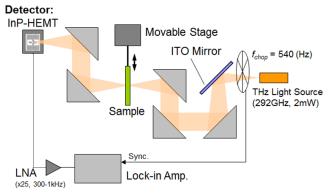


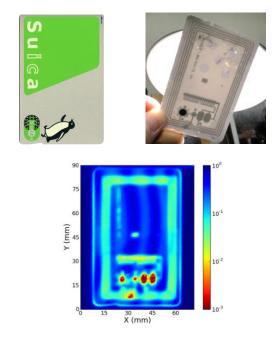
Fig. 8. Measured responsivity (left) and the channel voltage $R \cdot \Delta I$ (right) as a function of gate voltage V_{g1} , at 292 GHz radiation at different temperatures. R is the channel resistance. ΔI (I with radiation -I without radiation) is the difference induced in drain current by the incoming terahertz radiation.

dramatically increases when the parts of 2D channel under the fingers of one of the two sub-gratings are depleted. The device under characterization is identical to the InAlAs/InGaAs/InP A-DGG HEMTs shown in Fig. 2 except for uninstalling the vertical cavity. The A-DGG HEMTs demonstrate a record-breaking responsivity of 2.2 kV/W and an excellent noise equivalent power of 15 pW/Hz^{0.5} at 1 THz at 300K as shown in Fig. 7 [18]. A fairly high responsivity (>0.5 kV/W) is also maintained over the frequencies beyond 2 THz. All these values are, to the authors' knowledge, the best ever reported at these frequencies.

We also conducted the responsivity measurement at low temperatures with ~300-GHz radiation. Figure 8 plots the measured responsivities. With decreasing the temperature resonanttype behavior with sharper peak (corresponding to the 1st plasmon mode) is clearly observed on its detection property. When THz radiation is absorbed the drain current



(a) Experimental setup for THz imaging using the HEMT detector.



(b) Photo images (upper) and THz imaging (lower) for an IC card
 Fig. 9. Imaging setup and results using an InP-based A-DGG HEMT.

increases by the photocurrent component. Photovoltaic signal intensities are calculated as the product of the photocurrent and the output impedance of the HEMT, which are also plotted in Fig. 8. There is a good coincidence on the peak positions between the measured responsivity peaks and calculated photovoltaic signal peaks. It is worth noting that A-DGG HEMT can work for resonant-mode ultrahigh sensitive detection at low temperatures even for rather low sub-THz radiation.

The response speed of the 2D plasmon should be very high because the plasma wave velocity is higher by 2 orders of magnitude than the electron drift velocity in conventional HEMTs [1]. On the other hand, photovoltaic signal is given by the product of the photocurrent and the impedance

of the depleted region. The HEMT device has a capacitive structure between the channel and the gate, and the depleted region has high impedance. Thus, here is a RC (resistive and capacitive) lag circuit in the channel. Equivalent RC values corresponding to the unit cell of the 2D plasmon cavity and the depleted portion with submicron-order dimensions is estimated to be as small as picoseconds. Therefore very fast speed THz detection beyond tens of Gbit/s could be feasible. Experimental verification of the device response speed is a future subject.

By utilizing the A-DGG HEMT detector we conducted THz imaging for an IC card in the setup shown in Fig. 9. The results clearly demonstrate the imaging of hidden substance of circuit/antenna components inside of the IC card with a nice contrast in a sub-mm resolution.

3. THZ LIGHT AMPLIFICATION BY INTERBAND POPULATION INVERSION IN GRAPHENE

3.1 Carrier Dynamics in Optically Pumped Graphene

Carrier relaxation dynamics at relatively high temperatures in optically pumped graphene is shown in Fig. 10. When the photogenerated electrons and holes are heated, collective excitations due to the carrier-carrier scattering, e.g., intraband plasmons should have a dominant roll to perform an ultrafast carrier quasi-equilibration (Fig. 10(b)) Then carriers at high-energy [19]. tails of their distributions emit the optical phonons, cooling themselves and accumulating around the Dirac points (Fig. 10(c)). We numerically simulated the temporal evolution of

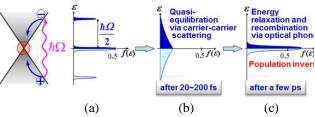


Fig. 10. Carrier dynamics in optically pumped graphene.

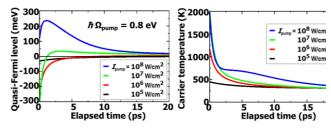


Fig. 11. Numerically simulated time evolution of the quasi-Fermi level (left) and carrier temperature (right) of monolayer graphene after impulsive pumping with a pumping photon energy of 0.8 eV [20].

the quasi-Fermi energy and carrier temperature after impulsive pumping with 0.8-eV photon energy [20]. As shown in Fig. 11, due to a fast intraband relaxation (ps or less) and relatively slow interband recombination (>>1ps) of photoelectrons/holes, the population inversion is obtainable under a sufficiently high pumping intensity > 10^7 W/cm² [20].

It is noted that the population inversion is a prerequisite for but does not mean the gain, because we have the Drude absorption by carriers in graphene. A quantity that determines the gain at frequency ω is the real part of the net dynamic conductivity $\operatorname{Re} \sigma_{\omega}$ consisting of the intraband $\operatorname{Re} \sigma_{\omega}^{\operatorname{intra}}$ and the interband $\operatorname{Re} \sigma_{\omega}^{\operatorname{inter}}$ contributions; the negative values of $\operatorname{Re} \sigma_{\omega}$ give the gain. $\operatorname{Re} \sigma_{\omega}$ is proportional to the absorption of photons with frequency ω and given by:

Re
$$\sigma_{\omega}$$
 = Re $\sigma_{\omega}^{\text{inter}}$ + Re $\sigma_{\omega}^{\text{intra}}$
 $\approx \frac{e^2}{4\hbar} (1 - 2f_{\hbar\omega}) + \frac{(\ln 2 + \varepsilon_F / 2k_B T)e^2}{\pi\hbar} \frac{k_B T \tau}{\hbar (1 + \omega^2 \tau^2)},$ (1)

where *e* the elementary charge, \hbar is the reduced Planck constant, k_B the Boltzmann constant, and τ the momentum relaxation time of carriers. The intraband contribution Re $\sigma_{\omega}^{\text{intra}}$ corresponds to the Drude-like absorption and is always in positive contributing as a loss. In the optically or electrically pumped graphene, the excess electrons and holes occupy the states up to the quasi-Fermi level ϵ_F in conduction and valence band, respectively. In this case, Pauli blocking prevents the absorption of photons with energies smaller than $2\varepsilon_F$, and the recombination of electrons and holes at energies corresponding to the photon energy might lead to stimulated photon emission (generation). In this case, the interband conductivity reaches the negative maximum value of $-e^2/4\hbar$.

Typical simulated results for Re σ_{ω} are shown in Fig. 12 as functions of time and frequency at a fixed pump intensity 1×10^8 W/cm² with momentum relaxation times $\tau = 3.3$ ps (left) and $\tau = 10$ ps (right), respectively. To focus on the negative conductivity area the positive conductivity area is clipped to the null level with red color. It is clearly seen that the gain spectral bandwidth widen, and broad terahertz gain bandwidth from ~1.5 to ~10 THz is obtained on picoseconds timescales after pumping for high-quality graphene with $\tau = 10$ ps.

3.2 Observation of Amplified Stimulated THz Emission

We conducted THz time domain spectroscopy for fs-laser pumped graphene samples and showed that graphene amplifies an incoming terahertz field [21-23]. An exfoliated monolayer-graphene/SiO₂/Si sample was placed on the stage and a 0.12-mm-thick CdTe(100) crystal was placed on the sample, acting as a THz probe pulse emitter as well as an electrooptic sensor [22]. A single 80-fs, 1550-nm, 4-mW, 20-MHz fiber laser was used for optical pump and probe signals as well as generating the THz probe beam. The THz probe pulse double-reflect to stimulate the THz emission in graphene, which is detected as a THz photon echo signal (marked with number "2" in Fig. 13(a)) [22]. Figure 13(b) shows the measured temporal response. The secondary pulse, the THz photon echo signal, obtained with graphene (GR) is more intense compared with that obtained without graphene. When the pumping intensity weakens below 1×10^7 W/cm² a threshold like behavior can be seen in Fig. 13(c), testifying to the light amplification by stimulated

emission of THz radiation. A Lorentzian-like normal dispersion around the gain peak also provides a manifestation of the occurrence of amplification attributed to stimulated emission of photocarriers in the inverted states. The Raman spectroscopic measurement for the graphene sample identified the defect level of the sample to be quite low with almost no "D" band peak [23]. The momentum relaxation time τ was characterized to be 3.3 ps at room temperature by the ratio of the Gband peak to the D-band peak intensity [23]. By using this τ value in Eq. (1) the gain-spectral profile is calculated as shown in Fig. 13(d), showing qualitative agreement with the observed results in Fig. 13(c). If the gain medium of graphene is installed in a pertinent cavity, it will lead to a new type of THz lasers [24].

However, obtained gain factor exceeds the theoretical limit ($\pi e^2 / \hbar c \approx 2.3\%$) given by the quantum conductance $e^2/4\hbar$ as discussed in 3.1 by more than one order of magnitude. We consider any artifact caused in experimental setup (gain multiplication due to multiple reflection, reflective index change due to increase in free carriers, etc..)

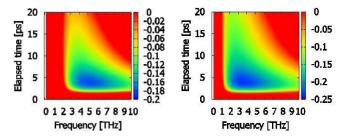


Fig. 12. Simulated time evolution of the terahertz dynamic conductivity of graphene after impulsive pumping with a photon energy 0.8 eV at an intensity 10^8 W/cm² at 300K. The carrier momentum relaxation time was assumed to be 3.3 ps (left) and 10 ps (right), respectively.

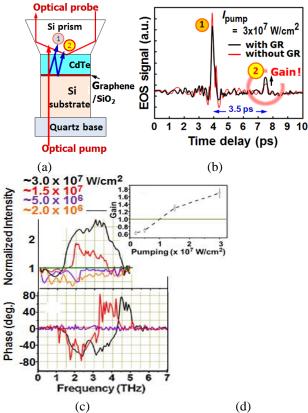


Fig. 13. THz time-domain spectroscopy for 80-fs infrared-laser pumped graphene. (a) pump and probe geometry, (b) temporal response of the THz probe pulse with the photon-echo signal, (c) Fourier spectra normalized to the one without graphene and gain vs. pumping intensity [22], (d) calculated gain spectra for $\tau = 3.3$ ps at t = 3.5 ps corresponding to the experimental conditions shown in Fig. 13(c).

and eventually revealed that this giant gain was originated from the amplified stimulated plasmon emission by the excitation of surface plasmon polaritons (SPPs) which was theoretically revealed and experimentally verified by the authors [25, 26] which will be described in detail in Section 4. At the similar time of the authors' observation of terahertz stimulated emission in optically pumped graphene, Li et al. has demonstrated observation of population inversion and stimulated

near-infrared emission at the frequencies on verv short timescales (~200 fs) [27]. They intensively pumped graphene with a pumping photon energy of 1.55 eV and with the pump fluence two to three orders of magnitude higher than our experiments. Then, before starting the optical phonon emission they impinged a nearinfrared femtosecond pulse with a slightly low photon energy of 1.16 or 1.33 eV at the timing shown in Fig. 10(b) to stimulate the electronhole recombination, getting near-IR photon emissions whose photon

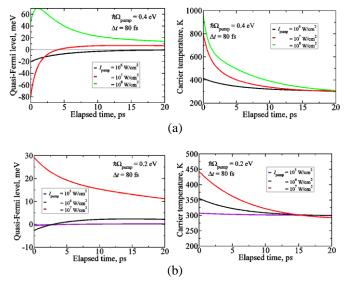


Fig. 14. Numerically simulated time evolution of the quasi-Fermi level (left) and carrier temperature (right) of monolayer graphene after impulsive pumping with a pumping photon energy of (a) 0.4 eV and (b) 0.2 eV.

energies correspond to the direct transition energies of these carriers. Generally, as is discussed in Fig. 10, the carrier-carrier scattering lowers the quasi-Fermi energy, preventing from the

population inversion. However sufficiently intense pumping can keep the inverted population since the earliest timing after pumping as they observed the stimulated near-IR emission.

3.3 Toward the Creation of Graphene THz Injection Laser

Figure 14 plots simulated time evolution of quasi-Fermi levels and electron temperatures for different pumping photon energies when graphene is impulsively pumped at t= 0 s. It is clearly seen that optical pumping with rather high photon

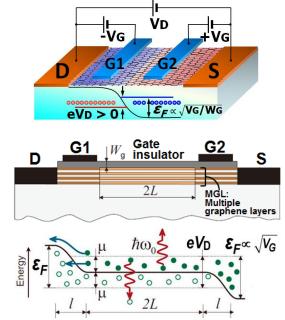


Fig. 15. Schematic bird's view (upper), cross section (middle), and band diagram (lower) for a graphene THz injection laser implemented in a dual-gate graphene-channel FET structure.

energy of the order of "~eV" significantly heats the carriers, which dramatically increases the pumping threshold, preventing from population inversion [28]. Hence, the pumping photon energy should be reduced to obtain a higher THz gain even at room temperature. In such a sense, current injection pumping is the best of solution to cope with this issue because electrical pumping can serve any pumping energy below the order of "meV" when a p-i-n junction is formed like semiconductor laser diodes.

Dual gate structure can make a p-i-n junction in the graphene channel as shown in Fig. 15 [6]. Gate biasing controls the injection level, whereas the drain bias controls the lasing gain profiles (photon energy and gain). To minimize undesired tunneling current that lowers the injection efficiency the distance between the dual gate electrodes must be sufficiently long [6, 29]. The structure- and material-dependent characteristics of the negative dynamic conductivity in a graphene p-i-n structure have been theoretically investigated and their superiority against those for optical pumping has been confirmed [29].

When graphene is installed in a proper terahertz cavity as a gain media, it is expected to perform a lasing operation. Due to the pi-electron's orbital emitted terahertz photons have inplane components of the electric field intensity. Thus the selection rule permits the propagation of terahertz photons perpendicular to and/or parallel to the graphene plane. Therefore vertical cavity [24] as well as waveguide-type cavity structures [30] can be implemented to making a graphene terahertz laser. From the view point of higher quantum efficiency and hence less pumping threshold, a waveguide cavity is superior because it can take a wider gain overlapping area along propagating the terahertz photons inside the cavity [30. Recent development in epitaxial graphene synthesis technology enables multiple-layer stacking with keeping the monolayer graphene layers [30]. Waveguiding the THz emitted waves with less attenuation is another key issue.

4. GIANT THZ GAIN AND PLASMONIC LASING IN POPULATION-INVERTED GRAPHENE

4.1 Giant THz Gain via Excitation of Surface-Plasmon-Polaritons in Inverted Graphene

As is described in 3.1, the negative THz conductivity of the monolayer graphene originated from the interband population inversion cannot exceed the quantum conductivity ($e^2/4\hbar$). To overcome this quantum-conductance limit, the use of the surface plasmon polaritons (SPPs) is a promising and important idea. Due to its extremely slow-wave nature (three to four orders of magnitude lower than photon speed), effective interaction efficiency can be increased by three to four orders (on the order of the ratio of the speed of plasmons to that of the photons). This increase results in orders of magnitude increase in the gain coefficient. We theoretically discover the amplification of surface plasmon-polaritons when traveling along the graphene-channel waveguide under population inversion [25]. We analyzed the surface plasmons (SPs) propagating along optically pumped single-graphene layer (SGL) and multiple-graphene layer (MGL) structures. It has been shown that at sufficiently strong optical pumping when the real part of the dynamic conductivity of SGL and MGL structures becomes negative in the THz range of frequencies due to the interband population inversion, the damping of the THz SPs can give way to their amplification. Due to the relatively small SP group velocity, the absolute value of their absorption coefficient (SP gain) can be large, substantially exceeding that of optically pumped structures with dielectric waveguides. A comparison of SGL and MGL structures shows that to maximize the SP gain the number of graphene layers should be properly chosen [25].

Compared with the THz lasing due to the stimulated emission of the electromagnetic modes (photons), the stimulated plasmon emission by the interband transitions in population inverted graphene can be a much stronger process. The plasmon gain under the population inversion in the intrinsic graphene has been theoretically studied in Refs. 25, 30, and 31. The non-equilibrium plasmons in graphene can be coupled to the TM modes of electromagnetic waves when pertinent structures and/or spatial charge-density distributions are arranged to excite the SPPs, resulting in the SPP formation and propagation. As shown in Ref. 25, the plasmon gain in the pumped graphene can be very high due to the small plasmon group velocity in graphene and strong confinement of the plasmon field in the vicinity the graphene layer, see Fig. 16 (left). The propagation index (effective refractive index for SPPs) ρ of the graphene SPP along the *z* coordinate is derived from Maxwell's equations [25]:

$$\sqrt{n^2 - \rho^2} + n^2 \sqrt{1 - \rho^2} + \frac{4\pi}{c} \sigma_{\omega} \sqrt{1 - \rho^2} \sqrt{n^2 - \rho^2} = 0, \qquad (2)$$

where *n* is the refractive index of the substrate, *c* is the speed of light in vacuum, and σ_{ω} is the conductivity of graphene at frequency ω . When $n = 1, \rho$ becomes [25]

$$\rho = \sqrt{1 - \frac{c^2}{4\pi^2 \sigma_{\omega}^2}} \quad (3)$$

The absorption coefficient α is equal to the imaginary part of the wave vector along the *z* coordinate: $\alpha = \text{Im}(q_z) = 2 \text{Im}(\rho \cdot \omega/c)$. Figure 16(b) plots simulated α for the monolayer graphene on a SiO₂/Si substrate (Im (*n*) ~ 3 × 10⁻⁴) at 300K [26]. The quasi-Fermi energies are parameterized at $\varepsilon_F = 10, 20, 30, 40, 50, 60$ meV and the carrier momentum relaxation time $\tau_m = 3.3$ ps is assumed. The results demonstrate a giant THz gain (negative values of absorption), on the order of 10⁴ cm⁻¹. This giant gain comes from the slow wave nature of the SPPs. Since the absorption coefficients and the resultant gain coefficient (under the negative absorption conditions) are directly linked to the dynamic conductivity σ_{ω} , as shown in Eq. (3), the gain

spectra show a similar dependency on the momentum relaxation times and, therefore, on the graphene quality as σ_{ω} as discussed in Refs. [5, 6, 29, 33-35].

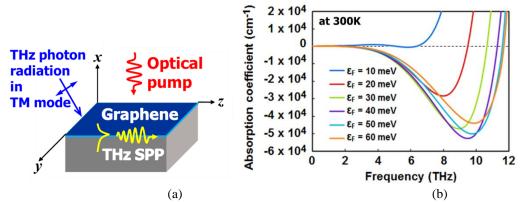


Fig. 16. Excitation of SPPs in optically pumped graphene. (a) Schematic image, (b) simulated frequency dependences of SPP absorption for monolayer population-inverted graphene on SiO2/Si substrate at 300K at different levels of population inversion (given by the quasi-Fermi energy $\varepsilon_F = 10, 20, 30, 40, 50, 60$ meV). Carrier momentum relaxation time in graphene is $\tau_m = 3.3$ ps. The results demonstrate giant THz gain (negative values of absorption) of the order of 10^4 cm⁻¹. (after Ref. [26].)

We conducted optical-pump, THz-probe and optical-prove measurements at room temperature for the intrinsic monolayer graphene, exfoliated from graphite and transferred onto a SiO₂/Si substrate [26]. The experiment is based on the time-resolved near-field reflective electrooptic sampling with fs-IR laser pulse for optical pumping and a synchronously generated THz pulse for probing the THz dynamics of the sample in the THz photon-echo manner. Fig. 17 shows the experimental setup and the pump/probe geometry. A 140-µm-thick CdTe crystal acting as a THz probe pulse emitter as well as an electrooptic sensor was placed on the exfoliated monolayergraphene/SiO₂/Si sample. The CdTe can rectify the optical pump pulse to emit the envelope THz probe pulse. The emitted primary THz beam grows along the Cherenkov angle to be detected at the CdTe top surface as the primary pulse (marked with "①" in Fig. 17), and then reflects interacting with the graphene sample. When the sample substrate is conductive, the THz probe pulse transmitting through the graphene again reflects back to the CdTe top surface and is electrooptically detected as the THz photon echo signal (marked with "(2)" in Fig. 17). Therefore, the original temporal response consists of the first forward propagating THz pulse (no interaction with graphene) followed by a photon echo signal (probing the graphene). The delay between these two pulses is given by the total round-trip propagation time of the THz probe pulse through CdTe. The measured waveforms and their corresponding gain spectra (Fig. 18) are well reproduced and showed a threshold behavior against the pumping intensity as theoretically predicted in Refs. [5] and [6].

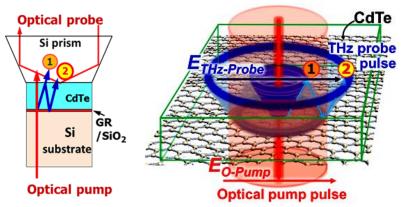


Fig. 17. Experimental setup showing the trajectories of the optical pump and THz probe beams. The polarization of the optical pump and the THz probe pulse are depicted with a red and dark-blue arrow. (after Ref. [26].)

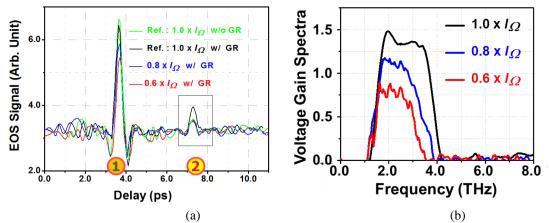


Fig. 18. Measured temporal responses (a) and corresponding voltage gain spectra (b) of the THz photonecho probe pulse (designated with "②") for different pumping intensities I Ω (3×10⁷ W/cm²), 0.8×I Ω , and 0.6×I Ω . (after Ref. [26].)

We observe the spatial distribution of the THz probe pulse under the linearly-polarized opticalpump and THz probe-pulse conditions. To measure the in-plane spatial distributions of the THz probe pulse radiation, the optical probe pulse position (at the top surface of the CdTe crystal) was changed step by step by moving the incident point of the optical pump pulse. The pumping intensity I_{Ω} was fixed at the maximum level. Fig. 19 shows the observed field distributions for the primary pulse and the secondary pulse intensity. The primary pulse field is situated along the circumference with diameter ~50 µm concentric to the center of the optical pumping position. On the other hand, the secondary pulse (THz photon echo) field is concentrated only at the restricted spot area on and out of the concentric circumference with the diameter ~150 µm, where the incoming THz probe pulse takes a TM mode, being capable of exciting the SPPs in graphene [24]. The observed field distribution reproduces the reasonable trajectory of the THz echo pulse propagation in the TM modes inside of the CdTe crystal as shown in Fig. 17 (assuming the Cherenkov angle of 30 deg. in CdTe and the SPP propagation ~10 µm). When the SPPs approach the edge boundary of the optically pumped area, they could mediate the THz emission, which was detected as the secondary THz probe pulse. The observed gain enhancement factor ~50 is in fair agreement with the theoretical calculations presented in Fig. 16.

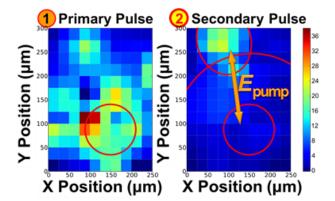


Fig. 19. Spatial field distributions of the THz probe pulse intensities. The primary pulse shows nonpolar distribution, whereas the secondary pulse shows a strong localization to the area in which the THz probe pulse is impinged to graphene surface in the TM modes. (after Ref. [26].)

4.2 Superradiant THz Plasmon Emission from Inverted Graphene-Metal Micro-Ribbon Arrays

The amplification of THz waves by stimulated generation of resonant plasmons in a planar periodic array of graphene plasmonic microcavities has been theoretically studied in Refs. 31 and 32. Typical device structure is depicted in Fig. 20(a) [32]. Graphene microcavities are confined periodically underneath the metal grating gates located on a flat surface of a thin dielectric layer (which can be, for example, h-BN, SiN, Al₂O₃). The external THz wave is incident upon the planar array of graphene microcavities at the normal direction to its plane with the polarization of the electric field across the metal grating gates. The graphene is pumped either by its optical illumination or by injection of electrons and holes from opposite metal gates in each graphene microcavity. In the latter case, the opposite ends of each graphene microcavity adjacent to the metal contacts have to be p- and n-doped. One can easily imagine a biasing scheme for applying dc voltages to successive metal contacts in the interdigital manner [6, 7] in order to ensure the carrier injection into each graphene microcavity. The carrier population and, hence, the dynamic conductivity are characterized by the quasi Fermi level and carrier temperature, as described in Eq. (1).

Figure 20(b) shows the contour map of the calculated absorbance as a function of the quasi-Fermi energy (which corresponds to the pumping strength) and the THz wave frequency for the array of the graphene microcavities with period L = 500 nm and the length of each microcavity W = 400 nm and the gate dielectric layer thickness d = 50 nm. In the amplification regime, the negative value of the absorbance yields the amplification coefficient. The value of Re[$\sigma_{Gr}(\omega)$] is negative above the solid black line in Fig. 20(b), corresponding to $\text{Re}[\sigma_{\text{Gr}}(\omega)] = 0$ (i.e., to transparent graphene). Above this boundary line, negative absorption (i.e., amplification) takes place at all frequencies and pumping strengths. The plasmon absorption resonances below the $\text{Re}[\sigma_{\text{Gr}}(\omega)] = 0$ line give way to the amplification resonances above this line. Plasmon resonances appear at frequencies $\omega = \omega_p(q)$ determined by the selection rule for the plasmon wave vector $q_n = (2n-1)\pi/a_{\text{eff}}$, where a_{eff} is the effective length of the graphene micro/nanocavity. The frequency of the plasmon resonance is determined mainly by the imaginary part of the graphene conductivity, while the real part of the conductivity (1) is responsible for the energy loss (for $\text{Re}[\sigma_{\text{Gr}}(\omega)] > 0$) or energy gain (for $\text{Re}[\sigma_{\text{Gr}}(\omega)] < 0$).

With increasing ε_F , the energy gain can balance the energy loss caused by the electron and hole scattering in graphene so that the net energy loss becomes zero, $Re[\sigma(\omega)] = 0$, which corresponds to graphene transparency. In this case, the plasmon resonance line exhibits a nonsymmetric Fano-like shape because the real part of graphene conductivity changes its sign across the plasmon resonance. In this case, the plasmon resonance linewidth is given solely by its radiative broadening (because the dissipative damping is close to zero in this case). Above the graphene transparency line $\text{Re}[\sigma_{\text{Gr}}(\omega)] = 0$, the THz wave amplification at the plasmon resonance frequency is several orders of magnitude stronger than away from the resonances (the latter corresponding to the photon amplification in population-inverted graphene). Note that at a certain value of the quasi-Femi energy, the amplification coefficient at the plasmon resonance tends toward infinity with the corresponding amplification linewidth shrinking down to zero. The unphysical divergence of the amplification coefficient is a consequence of the linear electromagnetic approach used in Refs. 31 and 32. This corresponds to the plasmonic lasing in the graphene micro/nanocavities in the self-excitation regime. The behavior of the amplification coefficient around the self-excitation regime is shown in Fig. 20(c) [32]. The lasing occurs when the plasmon gain balances the electron scattering loss and the radiative loss, see Fig. 20(d) [31]. It means that the plasmon oscillations are highly coherent in this case, with virtually no dephasing at all. The red arrow in Fig. 20(b) marks the quasi-Fermi energy corresponding to plasmonic lasing in the first plasmon resonance.

The plasmons in different graphene microcavities oscillate in phase (even without the incoming electromagnetic wave) because the metal contacts act as the synchronizing elements between the adjacent graphene microcavities [31]. Therefore, the plasma oscillations in the array of the graphene microcavities constitute a single collective plasmon mode distributed over the entire area of the array, which leads to the enhanced *superradiant* electromagnetic emission from the array. Extraordinary properties of a collective mode in the array of synchronized oscillators are well known in optics: the power of electromagnetic emission from such an array grows as the square of the number of the oscillators in the array [36].

It is important to stress that the giant amplification enhancement at the plasmon resonance is ensured by strong confinement of the plasmons in the graphene microcavities. As mentioned above, an elevated gain in graphene (approaching the negative of the plasmon radiative damping) is required to meet the self-excitation condition. However, the elevated gain would lead to strong dephasing of a plasma wave over quite long distance of its propagation (which corresponds to the non-resonant stimulated generation of plasmons [38, 39]). Therefore, strong plasmon-mode confinement in a single-mode plasmonic cavity is required to ensure the resonant stimulated generation of plasmons. Plasmon confinement to a single-mode microcavity also enhances the rate of spontaneous electromagnetic emission by the plasmon mode due to the Purcell effect [37]. It is expected that the confinement of plasmons in two-dimensional graphene microcavities (arranged in a chess-board array) could enhance the amplification even stronger.

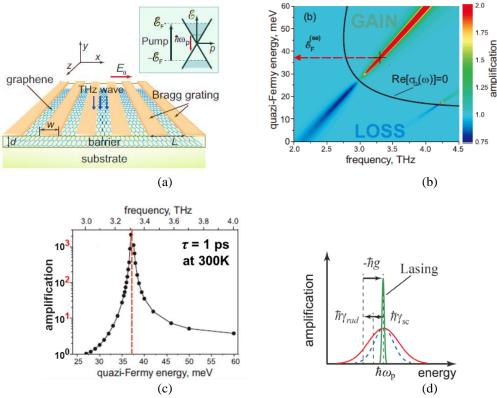


Fig. 20. (a) Schematic view of the array of graphene micro/nanocavities [32]. The incoming electromagnetic wave is incident from the top at normal direction to the structure plane with the polarization of the electric field across the metal grating contacts. The energy band structure of pumped graphene is shown schematically in the inset. (b) Contour map of the absorbance as a function of the quasi-Fermi energy and the frequency of incoming THz wave for the array of graphene microcavities with period L = 500 nm, the length of each graphene microcavity W = 400 nm, the gate dielectric layer thickness d = 50 nm, and the carrier momentum relaxation time in graphene $\tau_m = 10^{-12}$ s [32]. Red arrow marks the quasi-Fermi energy in the plasmonic lasing regime at the fundamental plasmon resonance. (c) The variation of the power amplification coefficient along the first-plasmon-resonance lobe [32]. (d) Schematic illustration of the energy rate balance in the plasmon lasing regime [31].

5. CONCLUSION

Recent advances in emission and detection of THz radiation from 2D electrons in III-V semiconductors and graphene were described. 2D plasmon resonance in HEMT structures as well as ultrafast non-equilibrium dynamics of massless electrons/holes together with surface plasmon polaritons in graphene are promising mechanisms for making new types of practical THz sources and detectors.

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D6. Photonic Microstructures for Silicon Photonics Applications

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Silicon (Si) is currently the most pervasive semiconductor material used in electronics. This ubiquitous semiconductor not only exhibits excellent electronic and mechanical properties but also is low-cost, abundant, non-toxic, and environmentally friendly. Si can be easily processed by various standard complementary metal–oxide–semiconductor and micro-electromechanical system technologies. However, because of the indirect optical transition in Si, the light-emission efficiency and optical-absorption coefficient are considerably low. Therefore, improving light emission from Si is one of the most challenging issues in photonics and material science [1]. Enhancement of the optical absorption in ultrathin Si is also important for applications to highly efficient photodetecting devices, including photo sensors and solar cells [2]. Furthermore, owing to its low-absorption loss, Si is a potential material for photonics in terahertz (THz) waves, which are undeveloped and located between the radio and light-wave regions (from 0.1 to 10 THz), with many potential applications such as in non-destructive imaging, spectroscopic sensing, and wireless communication [3]. An ongoing study on possible technology platforms is underway where confinement and interaction of THz waves can be achieved in thin planar structures with low loss.

Here photonic microstructures, especially photonic crystals (PCs), in which the refractive index varies periodically on a length scale comparable to the wavelength λ of interest, have attracted much attention as a powerful tool in photon manipulation. Recently, several reports have been presented on the introduction of two-dimensional (2D) PC slabs into crystalline Si as emitters [2, 4-7] as a step toward future integration with electronic devices. The ultralow emission efficiency of Si is primarily due to the nature of its electronic-band structure. Conduction-band electrons can only recombine with valence-band holes using phonons. Thus, the radiative emission rate in Si is much lower than that in direct bandgap semiconductors. According to the quantum theory, the emission rate depends not only on its electronic states but also on the optical environment of the electromagnetic modes resulting from light-matter interaction. Thus, the rate can be determined by the photonic density of states and the electric field strength at the emitter position. Consequently, controlling the spatial distribution of the optical modes is important when manipulating the emission. If the emitter is placed inside an optical cavity, the increase in the photonic local density of states and electric field strength enhances the emission rate of the cavity optical mode by a factor of Q/V (known as the Purcell effect), where Q is the cavity quality factor and V is the mode volume. The photoluminescence (PL) of Si PC cavities with different volume V at room temperature was investigated [5]. The cavity mode intensity, estimated from the observed PL signal by considering the extraction and collection efficiency of each cavity mode, increased as the volume V decreased according to the Purcell effect. The increase in emission with the introduction of a PC cavity at the resonant wavelength was estimated to be up to 200–300-fold [4, 6, 7], as shown in Fig. 1. This large enhancement was believed to be due to both the Purcell effect and the emission pattern control, where light emission is directed to the desired direction by photon confinement through the cavity resonance, leading to improvement in the light-extraction efficiency.

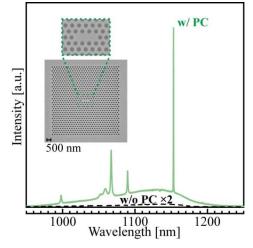


Fig. 1. PL spectra from Si with and without PC. Inset shows a scanning electron micrograph of a fabricated PC.

Improving the photon-to-electron conversion efficiency of photodetecting devices, including photo sensors and solar cells, using an ultrathin-film photoelectric conversion active layer is important for several reasons: enhanced carrier extraction, reduced material usage, and simplified fabrication. To enhance the efficiency therefore, an effective method of trapping (and ultimately absorbing) photons within the ultrathin active layer is necessary. Various methods that precisely manipulate the photon properties have been demonstrated using PCs, which include the photonic band-edge modes or unique dispersion curves of a 2D PC with a large area to external radiation as applied to lasers [8], light-emitting diodes [9], and thermal emitters [10].

If the incident light is coupled to the resonant mode of the PC, enhanced optical absorption (which is opposite to emission) and ultimately improved photoelectric-conversion efficiency may be realized even in an ultrathin active layer. Enhancement of the photoelectric-conversion efficiency of an ultrathin (50 nm $\sim \lambda/17$) Si active-layer photodetecting device using a 2D PC has been successfully demonstrated [11], as shown in Fig. 2. The experimentally observed photocurrent of the fabricated PC device increased by a factor of ~ 20 at the photonic band-edge wavelength relative to that of a control device without a PC owing to the resonance of the band-edge mode. In solar cell applications that require broadband optical absorption enhancement, the use of higher order modes in the vertical direction of the Si photovoltaic layer, which can be produced by increasing the thickness, was numerically investigated [12]. Moreover, the photonic super-lattice structure was explored to produce more photonic band-edge modes that lead to further optical absorption. The average absorption of 400-nm-thick (from $\sim \lambda$ to $\sim \lambda/2$)

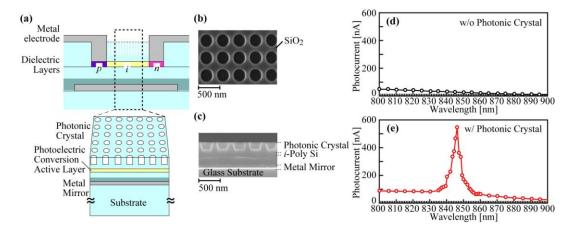


Fig. 2. (a) Schematic of PC photodetecting device. Scanning electron micrograph of planar view (b) and cross-sectional view (c). Measured photocurrent spectrum of the device without PC (d) and with PC (e).

microcrystalline Si photovoltaic devices with wavelengths of 500–1000 nm, which are weighted to the solar spectrum (AM 1.5), increased almost twice (from 33% without PC to 58% using a 4×4 period super-lattice PC), outperforming the random textured structure [12].

THz waves have recently attracted much attention because of their unique applications. However, current THz-wave systems are cumbersome and expensive because they consist of bulky discrete components. To study smart THz-wave devices and systems, development of THz-wave integrated circuits (ICs) based on planar structures is promising. One of the candidates for interconnection in THz-wave ICs would be metallic transmission lines, which are based on a monolithic microwave IC process. However, when the frequency increases to the THz-wave region, the absorption and radiation losses become serious. Against this background, THz-wave 2D PC Si slabs were studied as platform technology for THz-wave manipulation with sufficient confinement and efficient interaction [13-18]. THz PC waveguides with ultralow propagation loss (~0.2 dB/cm) and ultralow bending loss (<0.2 dB/bend) in planar compact structures have been successfully developed in the 0.3-THz band owing to their strong THzwave confinement with low material loss [18]. 1.5-Gbit/s error-free THz-wave communication in PC waveguides of as long as 47 cm with bends of 28 times has been achieved [18], as shown in Fig. 3. In addition, trapping of THz waves propagating through free-space in a thin ($\sim\lambda/5$) planar PC slab using the photonic band-edge effect has been successfully demonstrated [13, 16]. The dramatic change in the transmission signal with varying Si resistivity indicates that the PC slab can potentially control THz waves [13, 16] and develop a perfect absorber [16, 17], which is a desirable component in reducing multiple reflection in compact THz -wave systems.

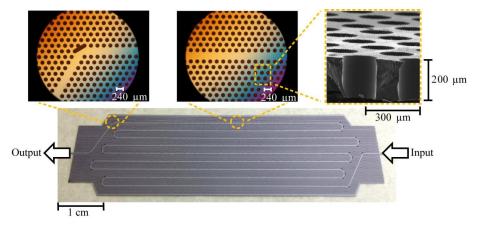


Fig. 3. Fabricated THz PC waveguide.

In conclusion, a photonic crystal based on silicon is a promising technology for manipulating light emission, photo detection, and THz waves.

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D7. Microwave Multiplexers for Readout of Superconducting Detector Array

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1. TRANSITION EDGE SENSOR (TES) ARRAY

Transition edge sensors (TES), thermal detectors based on the steep temperature dependence of the resistance of a superconductor at the operation temperature *T* close to its critical temperature *T*_C, are attractive for the following applications; 1. X- and γ -ray calorimeters (photon-counting mode) with more than one-order-of- magnitude better energy resolution than semiconductor detectors [1]; 2. Near-infrared photon counters with both the quantum efficiency close to 100% and the response time less than 200 ns. [2]; 3. Millimeter- and submillimeter-wave bolometers with more than four-order-of-magnitude better product of $(\text{NEP})^2 \times \tau$ than semiconductor bolometers cooled below 0.3 K [3], where NEP $[W/\sqrt{Hz}]$ is the noise equivalent power and τ is the response time. In both calorimeter and bolometer regimes, arrays with hundred pixels were developed and a larger-format array is a key issue for future practical use of TES. As the readout technique for such large number of pixels, a cryogenic multiplexer should be developed since it decreases the heat flow from 300-K to the cryogenic stage of typically ≈ 0.1 K through signal wires, resulting in the reduction of volume and power consumption of a cryocooler which dominates those of TES systems.

2. CRYOGENIC MULTIPLEXERS FOR READOUT OF TES ARRAY

For more than ten years, time-division multiplexing (TDM) [4] and frequency-division multiplexing (FDM) [5] schemes were studied which operate at typical output channel bandwidth $B \le 5$ MHz. Multiplexing of semiconductor detectors was based on TDM, since CMOS circuits are suitable for the fast switch of operating pixels, but difficult to contain high-Q and compact resonators required for FDM. However, in principle, FDM can exhibit better signal-to-noise ratio than TDM when the number of multiplexed pixels N increases. This is because all pixels are simultaneously active in the whole measurement time for FDM [6], while the operating time per pixel is inversely proportional to N for TDM. Since the surface resistance of superconducting resonators in microwave region is less than 1/100 of that of a bulk cupper, FDM based on high-Q superconducting resonators integrated on a chip are attractive [7]. Since the possible number of multiplexed pixels of FDM is roughly given by $N=B/S \sim kf_C/S$, increase of f_C from ~5 MHz to \sim 5 GHz is an effective way to increase N, where S is the spacing between neighboring resonances, $f_{\rm C}$ the middle of resonant frequencies, and k is the ratio of bandwidth to the resonant frequency. As a termination of a resonator, a normal-type superconducting quantum interference device (SQUID) with power consumption of ~ 1 nW/pixel at the same temperature stage as the TES, typically used for the low-noise TES readout, can be replaced by a dissipation-less-type SQUID, which has bigger advantage for larger N.

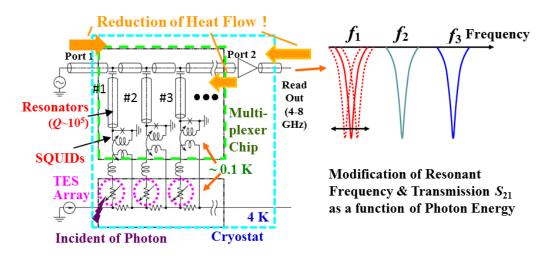


Fig. 1. Microwave multiplexer for TES readout.

3. PIONEERED WORK IN USA

The basic concept and operation of this microwave SQUID multiplexer was reported from National Institute of Standards and Technology (NIST), USA [8]. Mates et al. evaluated noise current of the SQUID as ~40 pA/ \sqrt{Hz} around 100 kHz [9], and demonstrated the flux ramp modulation which increases the dynamic range of SQUID without the conventional feedback operation [8, 9]. They also demonstrated the detection of 100-keV radiations from a Gd photon source with the energy resolution of 60-90 eV by multiplexed two-pixel TES [10].

Though this multiplexer is expected to overcome the limitation of conventional TDM and FDM schemes, following research and development are necessary for a successful demonstration of the readout of a large format array. First, the spacing of neighboring resonant frequencies should be accurately predicted by the design. Next, the noise is desired to decrease less than 10 pA/ \sqrt{Hz} which is the typical value of conventional SQUID-based multiplexers. Finally, a room-temperature electronics should be developed based on generators of microwave-comb which fit a series of $f_{\rm C}$, fast analog-to-digital converters with enough resolution, and up- and a down converters between the microwave and the baseband [11].

4. JAPANESE WORK

National Institute of Advanced Industrial Science and Technology (AIST), Japan, has started a study of the microwave multiplexer at 2011. They got the following results:

- (1) Finding the design rule which can fit theoretical resonant frequencies to the experimental ones within +/-0.02% for 4-8 GHz, i.e., the whole readout band [12]. Related result of NIST's report was within +/-0.04% in 4.6-5.7 GHz band [13].
- (2) Characterization of major noise sources in the system and their improvements [14]. AIST succeeded in obtaining 31 pA/ \sqrt{Hz} for 0.5-1000 kHz at 4 K that is dominated by a Johnson noise of a resistor in a low-pass filter for preventing the microwave leakage to the TES. This noise is expected to decrease by a factor of $1/\sqrt{40}$ at *T*=0.1 K.

They are continuing the research for the cooperation of the multiplexer with a TES and development of room temperature electronics.

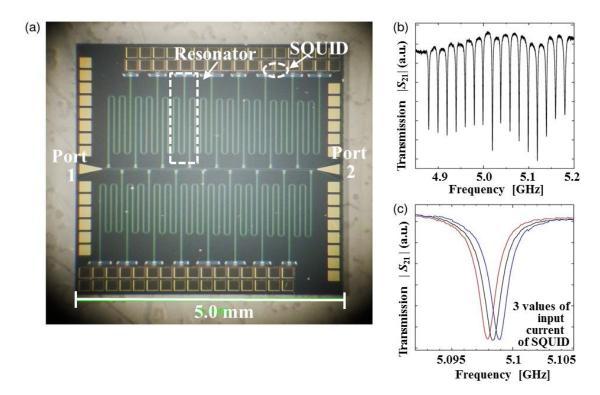


Fig. 2. Photo (a) and transmission vs. frequency of a multiplexer chip consisting of 16 resonators and SQUIDs. (c) Modification of transmission with 3 values of SQUID input.

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D8. High Capacity Optical Fiber Transmission Systems H. Toda

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In this section, I summarize recent development of high capacity optical fiber transmission systems and related technologies.

As described in the previous report 3 years ago, digital coherent technique is indispensable for high capacity transmission systems. All of the transmission experiments described here without notice are related to digital coherent. In a digital coherent system, influences of dispersion including polarization mode dispersion, laser phase noise, and Kerr nonlinearity can be compensated with digital signal processing circuit. Many efforts have been made for nonlinearity compensation with reduced circuit complexity [1-10]. A field trial of 100-Gbit/s Ethernet over an optical transport network was conducted using a real-time digital coherent signal processor [11]. Challenges for the next generation optical transport technologies and requirements of 100G DWDM systems are reviewed in [12-14].

Forward error collection (FEC) is also very important technology to improve system performance. Recent progress of soft-decision FEC was reviewed in [15, 16]. Combination of

nonlinearity equalizer and FEC was discussed in [17].

High optical spectral efficiency can be achieved with multi-level modulation format. The spectral efficiencies of 4.7 bit/s/Hz using 16 QAM [18], 9.1 bit/s/Hz using 64 QAM [19], 10 bit/s/Hz using 64 QAM [20, 21], and 14 bit/s/Hz using 256 QAM [22, 23] were demonstrated. Coherent receiver with digital-delay detection scheme was demonstrated for higher-order multilevel signal transmission [24-27]. Self-homodyne coherent detection was demonstrated to reduce receiver complexity [28].

Several techniques were proposed to generate higher-order optical QAM signal [29-32]. LiNbO3 modulators for advanced modulation format were reviewed in [33]. A linear optical IQ modulator for high-order multilevel modulation [34], IQ-coupling-loss-free polarization-switched QPSK modulator [35], and dual-carrier dual-polarization IQ modulator [36] were demonstrated.

As different approaches to improve optical spectral efficiency, nyquist WDM [37, 38] and CO (coherent optical) -OFDM [39, 40] transmission were demonstrated.

Significant progress has been made in space-division multiplexing over multi-core fiber (MCF). 109 Tbit/s over 16.8 km [41, 42], 305 Tbit/s over 10.1 km [43], and 1.01 Pbit/s over 52 km [44] transmissions were demonstrated. In [44], the spectral efficiency of 91.4 bit/s/Hz was obtained with 12-core MCF, 222-channel WDM of 456 Gbit/s PDM-32 QAM single-carrier FDM signals. For long distance EDFA repeatered transmission, 35.8 Tbit/s over 6,160 km [45, 46] 110.9 Tbit/s over 6,370 km [47], 688 Tbit/s over 1,500 km [48], and 140.7 Tbit/s over 7,326 km [38] transmissions were demonstrated. Note that the capacity-distance product for [38] and [48] exceeded 1 Exabit/s•km. These MCF transmission technologies are summarized in [49] and [50].

Recent research trends for MCF include enlarging effective area, reducing crosstalk, and reducing propagation loss [51-59]. The achievements are summarized in [60-64]. One approach to reduce influence of the crosstalk is bidirectional assignment between neighboring cores [65].

As related technologies to MCF, 7-core EDFA [66-69], 12-core EDFA [70] and optical connectors for MCF [71] were developed.

On the contrary, transmission experiment with mode-division multiplexing over few-mode fiber (FMF) [72] and multi-mode fiber [73] were demonstrated. In [74], repeatered transmission over FMF using a few-mode EDFA was demonstrated. PLC-type multi/demultiplexer for mode-division multiplexing was reported in [75, 76]. Efforts have been made to reduce differential mode delay of two-mode fiber [77-79] and four-mode fiber [80] transmission lines for WDM MIMO system.

In order to further increase the transmission capacity, few-mode multi-core fiber was

developed [81-83]. Transmission experiment was made using the fabricated fiber [84, 85]. Recent progress of MCF and FMF technologies are reviewed in [86].

In order to support long distance transmission, efforts are being made to realize pure-silicacore fiber with low propagation loss and large effective area [87]. Record low loss of 0.149 dB/km at 1550 nm was reported [88].

0.2-V on-off voltage at 25.8 Gbit/s was achieved with newly proposed interferometer-type electro-absorption modulator [89]. Silica-LiNbO3 hybrid integration [90-94], heterogeneous integration of active semiconductors with silica-based PLC [95-99], and monolithic integration using silicon photonics technology [100-102] are promising for future optical fiber transmission systems.

Phase-sensitive amplifier (PSA) is attractive to enhance signal-to-noise ratio of the received optical signals. HNLF-based PSA [103, 104] and PPLN-based PSA [105-107] are studied. Multi-span transmission using PPLN-based PSA was demonstrated in [108, 109].

List of Abbreviations

- EDFA Erbium-doped fiber amplifier
- FDM Frequency Division Multiplexing
- HNLF Highly nonlinear fiber
- MIMO Multiple-input multiple-output
- OFDM Orthogonal Frequency Division Multiplexing
- PDM Polarization Division Multiplexing
- PLC Planar lightwave circuit
- PPLN Periodically poled Lithium Niobate
- QAM Quadrature Amplitude Modulation
- QPSK Quadrature Phase-Shift Keying
- WDM Wavelength Division Multiplexing

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D9. Small Cell Configurations using RoF Entrance Network Technologies K. Tsukamoto Osaka Institute of Technology

ABSTRACT

This report addresses the wireless channel capacity in small cells provided by RoF technologies that can increase the capacity in a small cell with RoF entrance link and MIMO distributed antenna. Considering the SNR of the RF signal transmitted in the RoF entrance network and the interferences among wireless cells, computer simulation results show the optimized cell size to maximize the MIMO channel capacity.

1. INTRODUCTION

Mobile traffic is rapidly increasing to access variety cloud services, and their access methods diversifies in various type of radio air interfaces, 3.5G, 3.9G, 4G and beyond 4G, or commercial

or private WLAN. This trend requires the more and more efficient use of radio frequency, and the size reduction of radio cell (small cell) offering heterogeneous wireless access services [1]. Then the distribution of a huge number of radio base stations (RBSs) and the provision of more efficient and universal mobile backhaul networks will be needed in a wide area. For such universal mobile backhaul networks, the application of RoF (Radio over Fiber) technology is effective.

Applications of RoF technology to a backhaul for RAN have been studied [2]. Also, RoF over WDM-PON optical access network has been widely studied [3,4] as a next generation mobile backhaul because of its high capacity, low transmission loss and easy construction of a large number of RBSs. As a broadband and universal entrance network, References [5-7] have proposed Radio over Fiber Distributed Antenna System (RoF-DAS) over WDM-PON (Passive Optical Network) architecture. When implementing DAS on the WDM-PON architecture as shown in figure 1, RoF technologies enable the efficient and economical antenna distribution for several different types of MIMO RF signals [8].

This article reports the wireless channel capacity in small cells provided by RoF-DAS over WDM-PON that can increase the capacity in a small cell with RoF entrance link and MIMO distributed antenna. Considering the SNR of the RF signal transmitted in RoF and the interferences among wireless cells, computer simulation evaluates the optimized cell size to maximize the MIMO channel capacity.

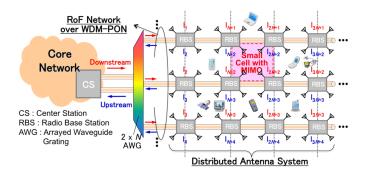


Fig.1. RoF-DAS over WDM-PON architecture [5-7].

2. ROF-DAS OVER WDM-PON ARCHITECTURE

Figure 2 shows the configuration of the downlink of RoF-DAS over WDM-PON. WDM scheme is used to multiplex a large number of bidirectional RoF links between a center station (CS) and RBSs. To multiplex radio signals with different types of radio air-interfaces for multiple sectors, each MIMO RF signal for a radio cell is simply bandpass-sampled [9], and multiplexed by optical TDM on a wavelength channel that is allocated to a RBS.

This proposal is effective in achieving transparency in each wavelength channel, and has been experimentally confirmed [5, 6]. In the experiment, the amplified optical pulse with its width of 100 ps and its repetition rate of 1GHz was divided into four streams, and each was modulated by 802.11n signals, whose mode was high-throughput mode (HT, modulation format: 64QAM), bandwidth was 40 MHz realizing the channel bonding, and center frequencies were 2.422 GHz and 5.230 GHz.

Optical pulses conveying two types of bandpass-sampled RF signals and also other two RF signals for an adjacent other cell, were time-division-multiplexed by use of optical delay lines and 3 dB couplers. At the RBS, the dropped optical signal was received by a photodiode and demultiplexed in time domain by use of an electrical switch (SW) driven by the gating signals extracted from the received optical signals with a PLL. After passed through BPF, we obtained the regenerated the original RF signals.

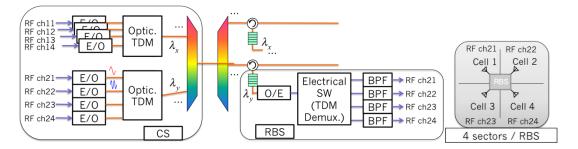


Fig. 2. Configuration for down link of RoF-DAS over WDM-PON.

3. SIMULATION FOR CHANNEL CAPACITY INVESTIGATION

The MIMO channel capacity provided by RoF-DAS over WDM-PON can be calculated by [10]

$$C_n = E\left[\log_2\left\{\det\left(\frac{P_t L_{RoF-n} G}{N_{RoF-n} L_{RF} + N_{Rx}} \boldsymbol{H} \boldsymbol{H}^H + \boldsymbol{I}_4\right)\right\}\right]$$
(1)

where $E[\cdot]$ denotes the ensemble average of fading statistics. P_t , G, L_{RoF-n} , N_{RoF-n} , L_{RF} , and N_{Rx} are the RF transmission power per channel at CS, the RF amplifier gain at O/E in a RBS, the loss and the noise power added in the RoF link between CS and *n*-th RBS, the loss in the wireless channel,

and the receiver noise power at a terminal. H and I_4 are the channel matrix for wireless channel and the 4 × 4 unit matrix. Assuming transmitting IEEE 802.11n wireless LAN signals, the simulation selected the wireless channel matrix between the antennas of the RBSs and the mobile terminals defined in IEEE 802.11 standard [11].

Figure 3 shows the simulation model for a radio cell configuration. We assumed 1 km width service area. Each square cell is placed side by side. The channel capacity of each cell was investigated as the average capacity at 25 points in a cell. The averaged channel capacity per a small cell that was the farthest cell from CS, has been evaluated. The cell is most affected by the transmission loss and the reflection loss generated by optical filter of each RBS. Table 1 shows the parameters used in the simulation. Assuming the outdoor transmission, we set the boundary distance between the LOS environment and the NLOS environment d_{BP} to 30 m.

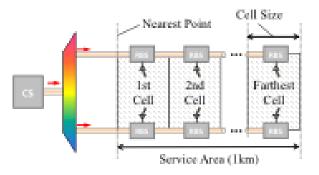


Fig.3. Simulation model of cell configuration.

Parameters	value		
	RF Frequency		2.422 GHz
	RF Bandwidth		40 MHz
Transm	ission Power per a	antenna	10 dBm
Height Diff	Height Difference between RBS and CS		10 m
Bre	Breakpoint Distance <i>d</i> _{BP}		30 m
Transmit	Transmitting Antenna Max Gain G _m		14 dBi
Horizontal H	Horizontal Half-power Beamwidth HPBWh		52.5 °
Horizon	Horizontal Front Back Ratio FBR _h		21.25 dB
Vertical Ha	Vertical Half-power Beamwidth <i>HPBW</i> _v		30 °
Vertic	Vertical Side Lobe Level SLL _v		-20 dB

Table 1. Parameters used in simulations.

Number of antenna at a RBS / a terminal			4 / 2
Receiving Antenna Spacing			0.06 m
Receiving Antenna Gain G _r			2.14 dBi
Receiver Noise Figure			5 dB
Wireless channel model			
	Rician K-factor	Shadow fading std.	
LOS	6dB	3dB	
NLOS	-∞	6dB	

Figure 4 shows the channel capacity at 1st cell versus the RF SNR γ_{T0} transmitted to the nearest point shown in figure 3 over the RoF link [7]. The vertical dashed line shows the experimentally obtained SNR γ_{T0} value of 27 dB. When the SNR is low, channel capacity increases as the SNR increases because the RoF noise link is dominant. When the SNR increases, however, the capacity was saturated to a constant value determined by the RF transmitting power at RBS, the wireless channel loss and the receiver noise at terminal. For smaller cell size, the saturation value increases higher because the receiving power becomes higher.

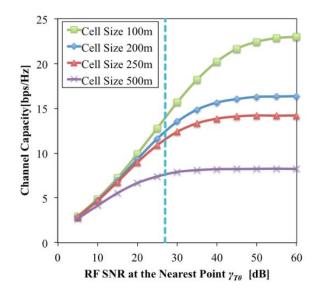


Fig. 4. Relationship between the average channel capacity in the cell and the RF SNR transmitted over RoF link.

It is observed that there is a trade-off relation between the cell size and the number of small cell unlike conventional entrance networks for radio cells, where the smaller cell size provides the higher channel capacity. To obtain the optimal cell size achieving the highest channel capacity, Ref. [7] evaluated the averaged channel capacity of the whole service area and the capacity of the farthest cell that is most affected by the accumulated loss in the WDM RoF links. Figure 5 shows the channel capacity per a square meter versus the cell size for different conditions of radio frequency allocation shown in figure 6. The RF SNR at the output of RoF link is assumed to be 40dB.

For all conditions, when the cell size becomes relatively small, the capacity is reduces because of the increase of the accumulation of the reflection loss in the cascaded RoF link. When the cell size is large, the capacity reduces as the receiver SNR at terminal decreases because of the fixed transmitting power of 10dBm. The capacity in a large cell size corresponds to the capacity without RoF link penalties.

Under the condition A with no interference, we can obtain the largest capacity. The optimal cell size to achieve the highest capacity becomes approximately 100 m, but its frequency utilization efficiency is low. Under the condition B and C, the obtained capacity are very low, because of co-channel interference for condition B and the lower received power for condition C. For the condition E, on the other hand, the capacity is constrained to the 70 % of that for condition A because of co-channel interferences, but the largest capacity can be obtained at the cell size of about 90 m with the largest radio frequency utilization efficiency.

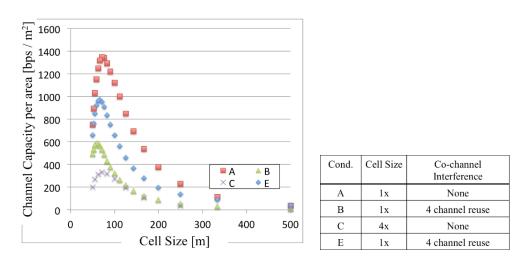


Fig. 5. Relationship between the channel capacity and the cell size at the RoF link SNR is 40 dB.

Condition A				
f1	f2	f5	f6	
f3	f4	f7	f8	
f9	f10	f13	f14	
f11	f12	f15	f16	

Condition E				
f1	f2	f1	f2	f1
f3	f4	f3	f4	f3
f1	f2	f1	f2	f1
f3	f4	f3	f4	f3
f1	f2	f1	f2	f1

Condition B				
f1	f1	f2	f2	f1
f1	fl	f2	f2	fl
f3	f3	f4	f4	f3
f3	f3	f4	f4	f3
f1	f1	f2	f2	f4

Condition C		
fl	f2	
f3	f4	

Fig. 6. Conditions for radio frequency allocation.

4. CONCLUSION

This article reported the wireless channel capacity in small cells provided by RoF-DAS over WDM-PON that can increase the capacity in a small cell with RoF entrance link and MIMO distributed antenna. Considering the SNR of the RF signal transmitted in RoF and the interferences among wireless cells enable results of computer simulation showed the optimized cell size to maximize the MIMO channel capacity.

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D10. Convergence of Wireless and Wired Technologies towards Next Generation Access Networks K. Iwatsuki Tohoku University

ABSTRACT

The bandwidth of next generation access networks will require beyond that of current optical access, handling the big data to download of huge data, images, and videos, as well as to upload a large number of sensor data, anytime and anywhere. The technical convergence with wired and wireless plays an important role to achieve the next generation access networks. In this report, we show the perspective on next generation access networks considering the resilience against disasters.

1. INTRODUCTION

Figure 1 shows the transmission speeds of core and access networks over time. The transmission speed of optical access has increased by around 100 times in the last decade. In order to accommodate the huge traffic from the broadband access networks, the transmission capacities of core networks are being dramatically accelerated with the use of time-division multiplexing (TDM), wavelength-division multiplexing (WDM), and digital coherent technologies; so that the total transmission capacity of WDM can reach up to 6 Tbps (107 Gbps x 640 wavelengths). As for the wireless access, the transmission speeds have also increased more than 1Gbps with wireless LAN (IEEE 802.11ac), and accelerated up to 100Mbps mobile access beyond 100Mbps with the 4G (LTE-A, LTE-B) mobile standardization, and start to the discussion towards "Beyond 4G" (B4G).

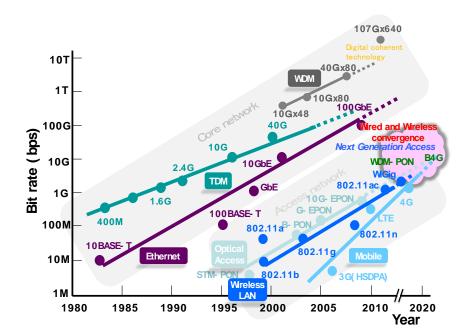


Fig. 1. Transmission speeds of core and access networks.

On the other hand, many serious problems have become clear as a result of the East Japan Great Earthquake, which exposed the weaknesses of the most advanced information communications network in the world by severing the mobile phone and optical fiber lines thus cutting off essential telecommunications services [1]. The demand for Information Communication Technology (ICT) is summarized in Fig. 2. "Resilience," "Green," "Smart,"

and "Secure" of and/or by the ICT are strongly required after we experienced the Great Earthquake. To achieve these requirements to the ICT, access networks will have flexibility to accommodate not only high speed but also low speed wireless interfaces as shown in Fig. 3.

In this report, we describe the perspective on next generation access networks considering the resilient ICT.

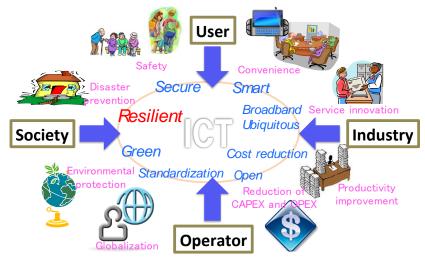


Fig. 2. Demand for ICT.

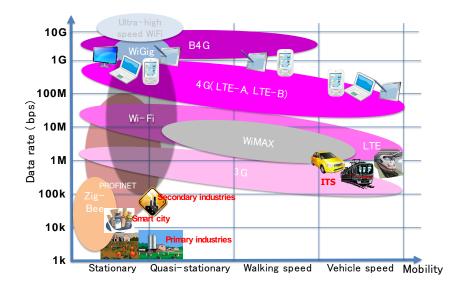


Fig. 3. Various wireless interface.

2. NEXT GENERATION ACCESS NETWORK

2.1. Concept of next generation access network

The concept of next generation access network in Fig. 4 shows the four orientations; broadband ubiquitous, green, resilient, cost reduction. These orientations of access network are realized with the following approaches.

(1) Broadband ubiquitous access networks will be achieved with introducing multilayer and small-cell architecture using high radio frequency.

(2) Green access networks will be achieved with simultaneously controlling the multilayered wireless networks, such as 3G, LTE, 4G, and B4G, according to the traffic distribution in service area.

(3) Resilient access networks will be achieved to be complimented by wired and wireless network each other and/or to introduce multilayered wireless network architecture.

(4) Construction cost of access networks will be reduced with sharing the transmission line and transceivers with many users, and with introducing the transceivers commonly used as wired and wireless, which are made by common components widely used in opt-electronics industries.

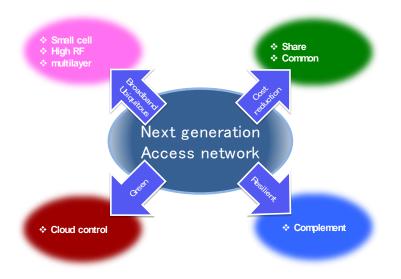


Fig. 4. Concept of next generation access network.

2.2. Optical backhaul

Figure 5 shows multilayered wireless access network with optical backhaul to achieve the above concept. The 3G service covers the large cell, which includes LTE, 4G, and B4G service areas, respectively, so that we call the multilayered wireless access network. The optical backhaul to accommodate LTE services is single star architecture. In order to accommodate 4G

and B4G services, we will apply PON architecture to the optical backhaul to reduce the cost. The 3G networks can be adopted control plain of LTE, 4G, and B4G networks as well. We can also accommodate sensor networks with the control plain of 3G networks.

We summarize the WDM access networks based on PON architecture in Fig. 6. These access networks are applied to the optical backhaul of multilayered wireless access network. The 3G and 4G services are supported with Coarse WDM (CWDM)-PON and Dense WDM (DWDM)-PON, respectively. We will provide B4G service with a distributed antenna network (DAN) with femto-cell architecture. We have proposed the radio over fiber (RoF) DAN over Super DWDM (SDWDM)-PON [2] to combine WDM access [3] and a DAN with multiple input multiple output (MIMO) technologies [4]. The provision of various wireless services per wavelength in WDM access can be accommodated. The WDM access will achieve the flexibility for non-uniform traffic distribution and the user-mobility in various wireless services.

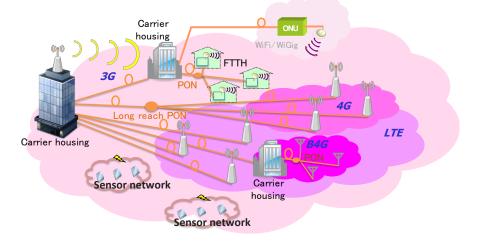


Fig. 5. Multilayered wireless access network with optical backhaul.

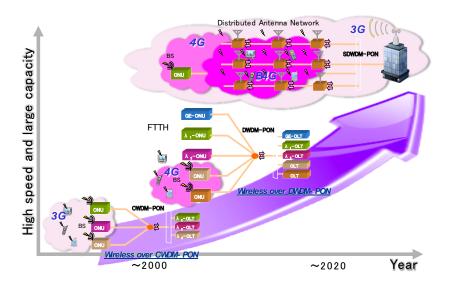


Fig. 6. Evolution of WDM access network.

2.3. Configuration of RoF-DAN over WDM-PON

In this section, we introduce the proposed RoF-DAN over WDM-PON. Figure 7(a) illustrates a configuration of WDM-PON, where two wavelengths are assigned to each BS as an up- and down-stream. We employ a $2 \times N$ arrayed waveguide gratings (AWGs) as a wavelength multi/demultiplexer, to achieve a low dissipation for accommodating a large number of BSs in single feeder fibers. At the CS, four MIMO RF signals for different four cells are multiplexed in the MIMO signal processing in Fig. 7(a). Each BS consists of an optical circulator without any wavelength selectivity to make it easy to add upstream signals and drop downstream signals. Optical filters, such as fiber gratings, at the BS are used to select a wavelength assigned to the BS. This configuration achieves the transparency of transmission lines through its lack of optical filters, and thus has scalability of upgrading wavelength channels in the future. To decrease the costs of operation, administration, and maintenance functions, as well as the production cost, we can introduce wavelength tunability in LDs and fiber gratings of BSs; that is colorless BS [4].

Figure 7(b) illustrates wavelength allocation for upstream and downstream. By using cyclic property of AWG, the wavelength of upstream are shifted with one wavelength against those of downstream. We require N + 1 wavelengths to accommodate N BSs over the WDM-PON, thus lead to enhancing the wavelength utilization.

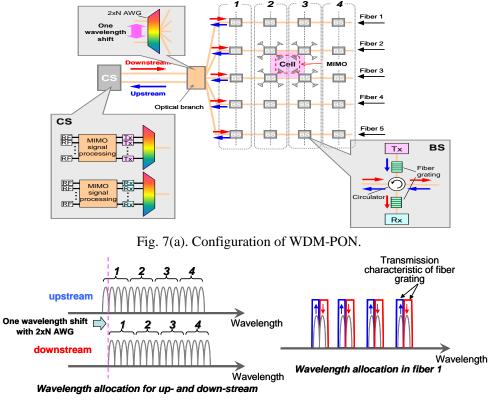


Fig. 7(b). Wavelength allocation of WDM-PON.

2.4. Experimental results of RoF-DAN over WDM-PON

Figure 8 shows our experimental setup to transmit downstream signals of RoF-DAN over WDM-PON with optical TDM and the signal transition diagram at each component [5]. We assumed that $2 \ge 2$ MIMO signal transmission in a cell as shown in Fig.2. Two wavelengths were used to realize $2 \ge 2$ MIMO signal transmission; two 802.11n RF signals in the 2.4 and 5 GHz bands were multiplexed in each wavelength with optical TDM and transmitted to the BS.

The two continuous lightwaves emitted from DFB-LDs were wavelength-multiplexed in Fig. 8 (a), and modulated with a lithium niobate Mach-Zehnder modulator (LN-MZM) driven with a return to zero (RZ) pulse of 100 ps pulse width at a 1 GHz repetition rate from a pulse pattern generator (PPG) in Fig. 8 (b). Two wavelength signals were amplified with an erbium doped fiber amplifier (EDFA) and demultiplexed with an AWG of 25 GHz wavelength spacing. Each wavelength was divided with a 3 dB coupler and modulated with each LN-MZM driven by 802.11n RF signals with 40 MHz bandwidth whose center frequencies were 2.422 GHz (ch 3) and 5.230 GHz (ch 46) from the vector signal generator (VSG) in Fig. 8 (c). At the output of each LN-MZM, we obtained the bandpass-sampled RF signals of the 2.4 and 5 GHz bands. The modulation and coding scheme (MCS) index of 802.11n RF signals was 15 [6] i.e. 64-quadrature amplitude modulation (QAM) orthogonal frequency division multiplexing (OFDM) signals. We employed optical delay lines and 3 dB couplers to optically multiplex the bandpass-sampled RF signals and dummy RF signals of an adjacent cell, as shown in Fig. 8 (d). The optically multiplexed RF signals were wavelength-multiplexed again and transmitted through the optical feeder fiber as a downstream signal.

The transmitted signals from the CS were distributed to each BS with the AWG, and the wavelength assigned at the BS was dropped by the 3-port circulator. The downstream signal dropped at the BS was converted by the photo diode transimpedance amplifier (PD-TIA), and demultiplexed with a high-speed electrical switch (SW) in Fig. 8 (f). The SW was driven by a control signal with a 300 ps pulse width at 1 GHz repetition rate from the PPG. The demultiplexed RF signals were converted to original RF signals with the band pass filter (BPF), which were transmitted as wireless signals from antennas at BS in Fig. 8 (g).

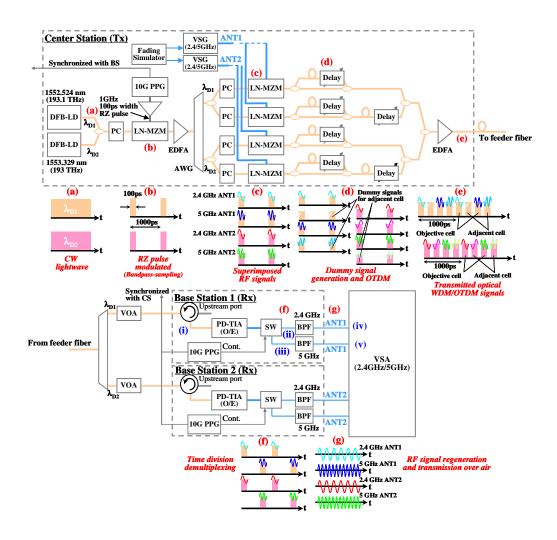


Fig. 8. Experimental setup and signal transition diagram.

Firstly, we performed back-to-back transmission using one wavelength, namely λ_{D1} signal to evaluate the performance of TDM and RF signal transmission as shown in Fig. 8. We evaluated the waveforms of time division multiplexed/demultiplexed RF signals and the constellations and error vector magnitude (EVM) value of 64-QAM OFDM signals at the BS by the vector signal analyzer (VSA).

The experimental results from (i) to (v) in Fig. 9 correspond to the measured points at the experimental setup in Fig. 8. To evaluate the TDM performance, we transmitted the optical pulse train without the RF modulation. Figure 9 (i) shows a transmitted optical pulse train from the CS, and Fig. 9 (ii) and (iii) show the demultiplexed electrical signals with the SW in BS. It clearly shows the good performance of TDM operation in the experimental setup. To evaluate the performance of transmitted RF signals, we modulated the optical pulse train with the RF signals. Figure 9 (iv) and (v) show the analyzed 2.4 and 5 GHz band RF signals after the BPF,

respectively. The EVM values of -26.0 and -23.2 dB were obtained, respectively. The optical powers at the PD-TIA input and the electrical powers at the VSG output were -3 and 5 dBm for Fig. 9(iv) and -3 and 10 dBm for Fig. 9(v), respectively.

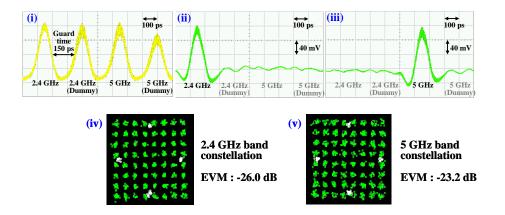


Fig. 9. Experimental results. (i) OTDM signal, (ii) and (iii) demultiplexed signals, (iv) constellation of 2.4 GHz band transmitted RF signal, (v) constellation of 5 GHz band transmitted RF signal.

Next, we performed back-to-back MIMO RF signal transmission using two wavelengths λ_{D1} The Fading simulator employed before VSG generated 2 x 2 MIMO transmission of and λ_{D2} . 2.4 GHz band RF signals under the Rayleigh fading model, in which the number of path, the delay between the paths, and the difference of loss between the paths were 2, 0.11 ns, and 8 dB, respectively. Figure 10(a) and (b) show the analyzed RF signals of λ_{D1} and λ_{D2} without the multipath fading, respectively. The EVM values of -26.5 and -24.1 dB were obtained, respectively, which are almost the same values of Fig. 9(iv). The optical powers at the PD-TIA input and the electrical powers at the VSG output were -1 and 8 dBm for both λ_{D1} and λ_{D2} , respectively. Figure 10(c) and (d) depict the RF spectrum of λ_{D1} and λ_{D2} , which clearly show the 802.11n RF signals of 40MHz bandwidth. These results lead to the good performance of WDM and TDM operation. To evaluate the performance of transmitted 2.4 GHz band RF signals with multipath fading, we operated the fading simulator. Figure 11(a) and (b) show the analyzed RF signals of λ_{D1} and λ_{D2} , respectively. The EVM values of -22.7 and -21.9 dB were obtained, respectively. The optical powers at the PD-TIA input and the electrical powers at the VSG output were the same values without the multipath fading. Figure 11(c) and (d) depict the RF spectrum of λ_{D1} and λ_{D2} , in which the frequency selective fading due to the fading simulator is still alive. The experimental results confirm the basic feasibility of optical TDM and bandpass-sampled MIMO RF signal transmission in the proposed RoF-DAN over WDM-PON architecture.

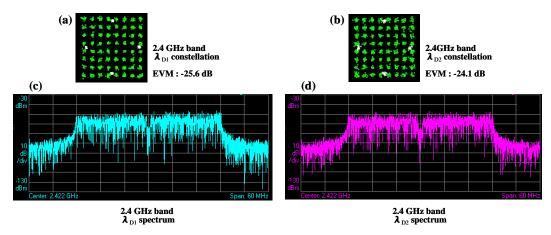


Fig. 10. Experimental results of MIMO RF signal transmission without multipath fading. (a) and (b) constellation of 2.4 GHz band transmitted RF signal in λ_{D1} and λ_{D2} , respectively. (c) and (d) 2.4 GHz band transmitted RF spectrum in λ_{D1} and λ_{D2} , respectively.

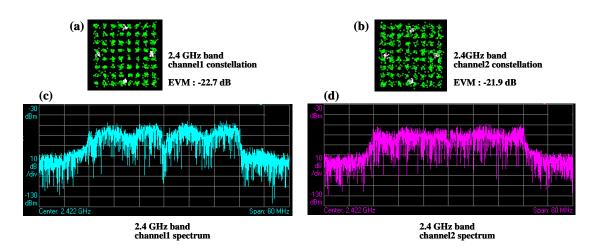


Fig. 11. Experimental results of MIMO RF signal transmission with multipath fading. (a) and (b) constellation of 2.4 GHz band transmitted RF signal in λ_{D1} and λ_{D2} , respectively. (c) and (d) 2.4 GHz band transmitted RF spectrum in λ_{D1} and λ_{D2} , respectively.

3. RESILIENT NETWORKS

The recent progress of cloud computing needs to easily connect to the big data with smart phones and tablet personal computers anywhere, at any time, with the multilayered wireless access network and sensor network. These networks forms the infrastructure for smart house, smart city, disaster prevention, remote medical care, health care, and so on, as shown in Fig. 12, and therefore we have to realize the resilience of and/or by the network in Fig. 5. A cloud radio access network (C-RAN) in Fig. 12 is the most promising approach to control the multilayered wireless networks to achieve the resilience in the disasters as well as the energy saving in usual according to the traffic distribution in the wireless service area.

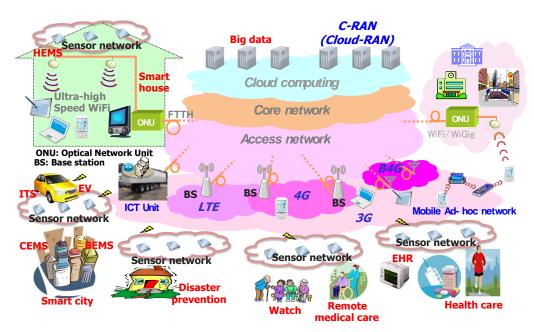


Fig. 12. Whole picture of resilient network.

Figure 13 shows the conceptual structure of multilayered communications network, which is to establish an alternative communication route and to develop its related technologies [7]. In case of a disaster, the commercial operator's cellular network may fall into severe traffic congestion or is damaged. When this happens, a mobile phone will automatically connect to a surviving local network, which will be private Wi-Fi, WiMAX, dedicated networks such as cable, satellite, and ITS (Intelligent Transportation Systems) networks. To enable such an autonomous network selection, a "Policy server" will be installed in each network. The policy server monitors its own network and decides whether or not the network can be open to third users based on its own network policy. Accordingly, a new function needs to be installed on mobile phones to select and access to one of the local networks. The decision is made with monitoring its surrounding radio environment and information broadcasted from the policy server in each network.

4. SUMMARY

We have described the perspective on next generation access networks taking into account of

the resilience ICT. The four orientations; broadband ubiquitous, green, resilient, cost reduction, were proposed as the concept of next generation access network. The multilayered wireless access network with optical backhaul based on WDM access was addressed as one of the most promising architecture to realize the concept.

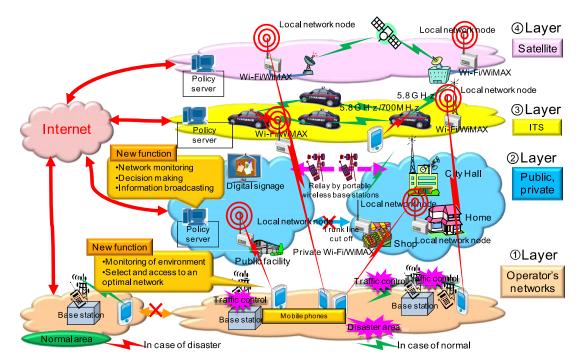


Fig. 13. Conceptual structure of multilayered communications network.

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D11. Optical Access Technologies for Mobile Fronthaul J. Kani NTT

1. INTRODUCTION

The deployment of Long Term Evolution (LTE) is rapidly spreading, and its upgrade to LTE-Advanced has already been standardized [1]. While LTE provides the peak rate of 300 Mbit/s downstream and 75 Mbit/s upstream, LTE-Advanced extends these to 1 Gbit/s downstream and 500 Mbit/s upstream. To support the explosion in mobile broadband traffic [2], further enhancement of the mobile broadband systems is under study in 3GPP [3].

To provide higher bandwidth in wireless/mobile systems, we generally need to decrease the cell size. The need to accommodate many more antennas, and the higher speeds involved, emphasizes the importance of cost-effective optical access technologies such as Passive Optical Network (PON) systems [4]. This part of the report summarizes recent progress in optical access technologies for supporting wireless/mobile systems.

2. C-RAN AND FRONTHAUL INTERFACES

In mobile networks, the base-station (BS) equipment, called eNodeB in LTE and LTE-Advanced, comprises two parts: one is Base Band Unit (BBU) for digital baseband processing and the other is Radio Equipment (RE) for transmitting and receiving wireless signals. RE can be replaced by Remote Radio Head (RRH) for realizing the centralized radio access network (C-RAN) architecture shown in Figure 1. The optical segment, i.e. between BBU and RRH in this architecture, is now called "mobile fronthaul".

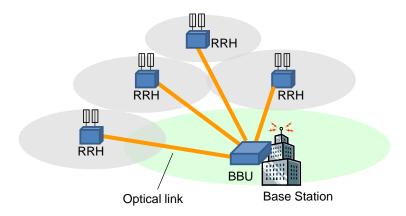


Fig. 1. C-RAN architecture.

A popular interface for connecting BBU and RRH is Common Public Radio Interface (CPRI) [5]. Based on CPRI, European Telecommunications Standards Institute (ETSI) is specifying Open Radio Equipment Interface (ORI) [6]. Such interfaces are called "fronthaul interfaces" in this report. The fronthaul interfaces carry digitized (i.e. IQ-sampled) radio components and so require very broad bandwidth, i.e. bandwidth of the order of the product of IQ sampling rate and quantization bit rate [7]. They also require very low latency and latency jitter to avoid interfering with the hybrid automatic repeat request (HARQ) procedure between BBU and user equipment (UE) [7].

The C-RAN architecture decreases equipment size and cost at the antenna points as well as realizing Coordinated Multi-point transmission/reception (CoMP), introduced in LTE-Advanced to increase the cell-average and cell-edge throughput, in a simple and effective manner [8]. Technologies to construct a practical C-RAN infrastructure such as multiplexing and compression techniques have been emerging in the last few years.

3. MULTIPLEXING AND COMPRESSION TECHNIQUES

One of the techniques to multiplex the fronthaul signals is wavelength-division multiplexing (WDM): an example configuration is illustrated in Figure 2. As shown in the figure, multiple CPRI links, e.g. for multiple antennas and multiple frequency bands, are transmitted over a single fiber by the use of WDM: each the fronthaul-interface signal uses a different wavelength pair. Additional delay and jitter are negligible because the multi/demultiplexing is done with a passive optical device such as an arrayed waveguide grating (AWG).

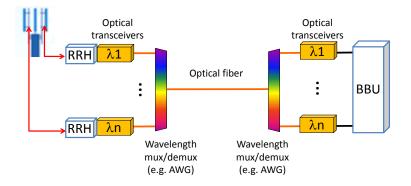


Fig. 2. WDM for fronthaul signals.

Another technique is CPRI over OTN defined by ITU-T. CPRI can be accommodated in OTN through the use of mapping procedures for Constant Bit Rate (CBR) signals defined in ITU-T G.709. Some careful consideration is needed as regards the jitter as described in Appendix VIII of ITU-T G.709.

Because the bandwidth of CPRI/ORI will become huge as mentioned above, CPRI compression techniques are being extensively researched [9, 10]. ORI compression is under study in ETSI. Network operators will be able to construct the C-RAN infrastructure by selecting and combining the multiplexing and compression techniques of the fronthaul interfaces in an effective manner.

4. MOBILE FRONTHAUL BASED ON PON

To provide higher bandwidth in wireless/mobile systems, we generally need to decrease the cell size, i.e. to densely set small cells. The point-to-multipoint optical access technology, i.e. PON technology, is very effective for such densely located small cells because a single optical fiber can be effectively shared among many RRHs as illustrated in Figure 3. There have been several studies to construct the mobile fronthaul with PON technology [9, 11, 12].

Currently standardized PON systems, such as ITU-T G-PON and XG-PON as well as IEEE 1G-EPON and 10G-EPON, are based on time-division multiplexing and time-division multiple access (TDM/TDMA). The TDM/TDMA PON technique enables multiple, e.g. 8 to 64, optical network units (ONUs) located in subscribers' home to share a single optical fiber via an optical splitter as well as to share the optical line terminal (OLT) including an optical transceiver located in the central office (CO), thus realizing a very economic system. However, the latency caused by the dynamic bandwidth allocation (DBA) becomes a problem when applying the TDM/TDMA PON to the mobile fronthaul. Recently, a novel bandwidth allocation scheme to address this has been reported [11]. The combination of TDM/TDMA PON with the adaptive compression method is very effective for constructing the mobile fronthaul for the radio access networks with

densely set small cells [9].

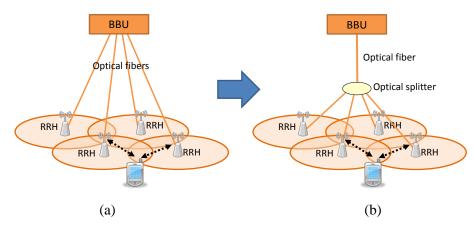


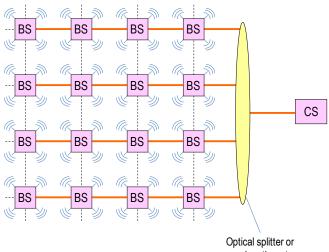
Fig. 3. Fronthaul architecture with (a) point-to-point fiber connections, and (2) PON configuration.

Another approach is to apply WDM-PON, in which each RRH is connected to BBU with a different wavelength pair [12]. Further studies will be done in the industry to compare the TDM/TDMA-PON and the WDM-PON in terms of cost and performance. ITU-T is standardizing the second next-generation PON (NG-PON2) as G.989 series. The NG-PON2 system adopts the combination of TDM/TDMA and WDM, so it will be possible to flexibly allocate the timeslot and wavelength resources to construct the mobile fronthaul depending on the requirement.

To further extend the mobile fronthaul architecture and increase the performance of smallcell networks, the Distributed Antenna System (DAS) is an interesting approach: Figure 4 shows a general schematic of DAS over a PON system. In DAS, each cell is surrounded by several antennas rather than putting an antenna at the center of the cell. Base stations (BSs) are connected to the central station (CS), which performs all signal processing. This configuration improves the performance of wireless communication by providing diversity gain; the bandwidth is readily increased by the use of multi-input multi-output (MIMO).

It is very reasonable to apply a PON system between BSs and CS in DAS, especially when the cell size is relatively small and the number of BSs is large because otherwise we would need a lot of optical fibers between BSs and CS.

One question is how to multiplex the signals to/from BS antennas. A DAS over WDM-PON technique has been proposed, in which radio-frequency signals from antennas are bandpass-sampled and multiplexed in the time domain in each BS and WDM is used to multiplex BS-to-CS signals [13, 14].



wavelength router

Fig. 4. Distributed Antenna System (DAS) over PON.

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